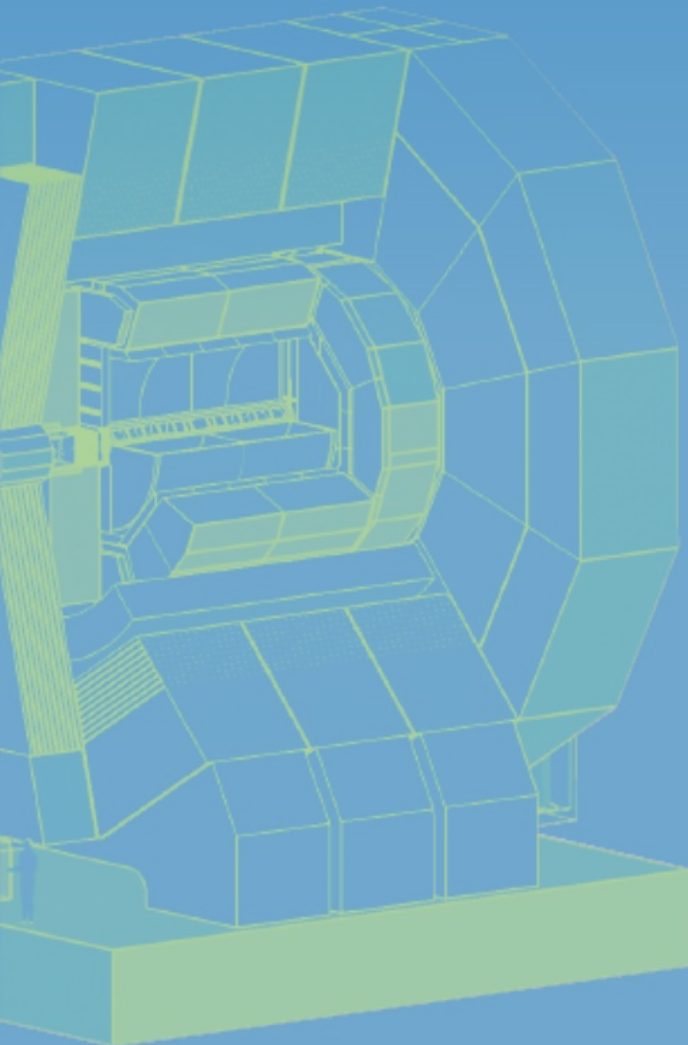




The  
International  
Large  
Detector

Letter of Intent



by the  
ILD Concept Group  
March 2009

DESY 2009-87  
KEK 2009-6

# ILD Calorimetry Concept

**Vincent Boudry**



*2009 Linear Collider Workshop of the  
Americas  
U. of New Mexico, Albuquerque  
30 sept. 2009*

# ILD Philosophy

## 1) Particle Flow **calorimetry**

- ▶ “basic requirement”: sep of WW/ZZ → 4j
  - ◆  $\sigma_Z/M_Z \sim \sigma_W/M_W \sim 2.7\% \oplus 2.75\sigma \text{ sep} \Rightarrow \sigma_E/E \text{ (jets)} < 3.8\%$
  - ◆  $60\%/\sqrt{E} \rightarrow 30\%/\sqrt{E} \Leftrightarrow +\sim 40\% \mathcal{L}$

## 2) Large TPC

- ▶ Precision and low  $X_0$  budget
- ▶ pattern recognition

## 3) Precision by Silicon detectors: vertex & Calo SET

- ▶ flavour tagging

## 4) Large acceptance

- ▶ Fwd Calorimetry:  
lumi, veto, beam monitoring
- Merging of LDC & GLD → ILD
  - ▶ “best dimension”
  - ▶ Optimisation studies

# Geometry: dimensions at large

- Mix of LDC & GLD parameters  
+ optimisation studies based on PandoraPFA

- Basic measuring rod

▶  $\sigma_{E_j}/E_j$  (& Bgd) vs

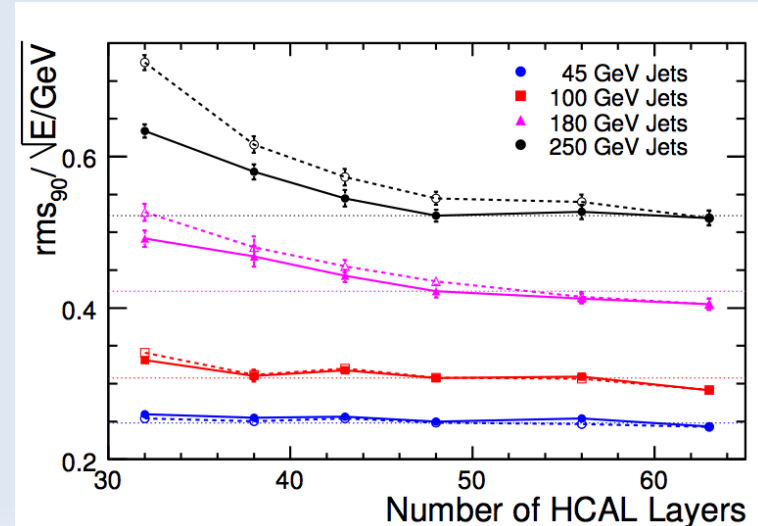
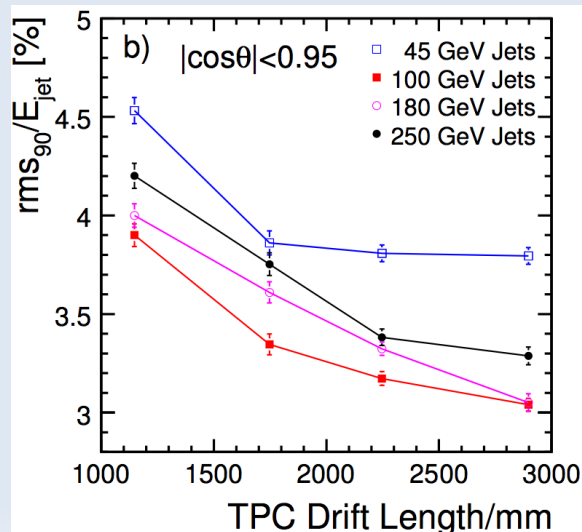
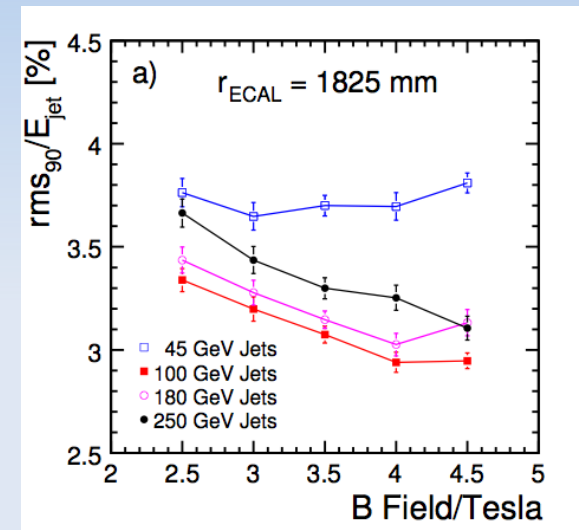
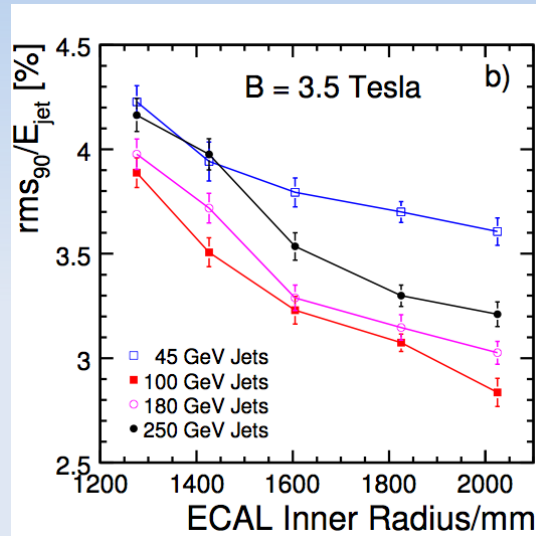
- ◆ TPC dimensions
- ◆ Radius Magnet (HCAL thickness)
- ◆ B field

- Other perfs:

▶  $\tau$  reconstruction

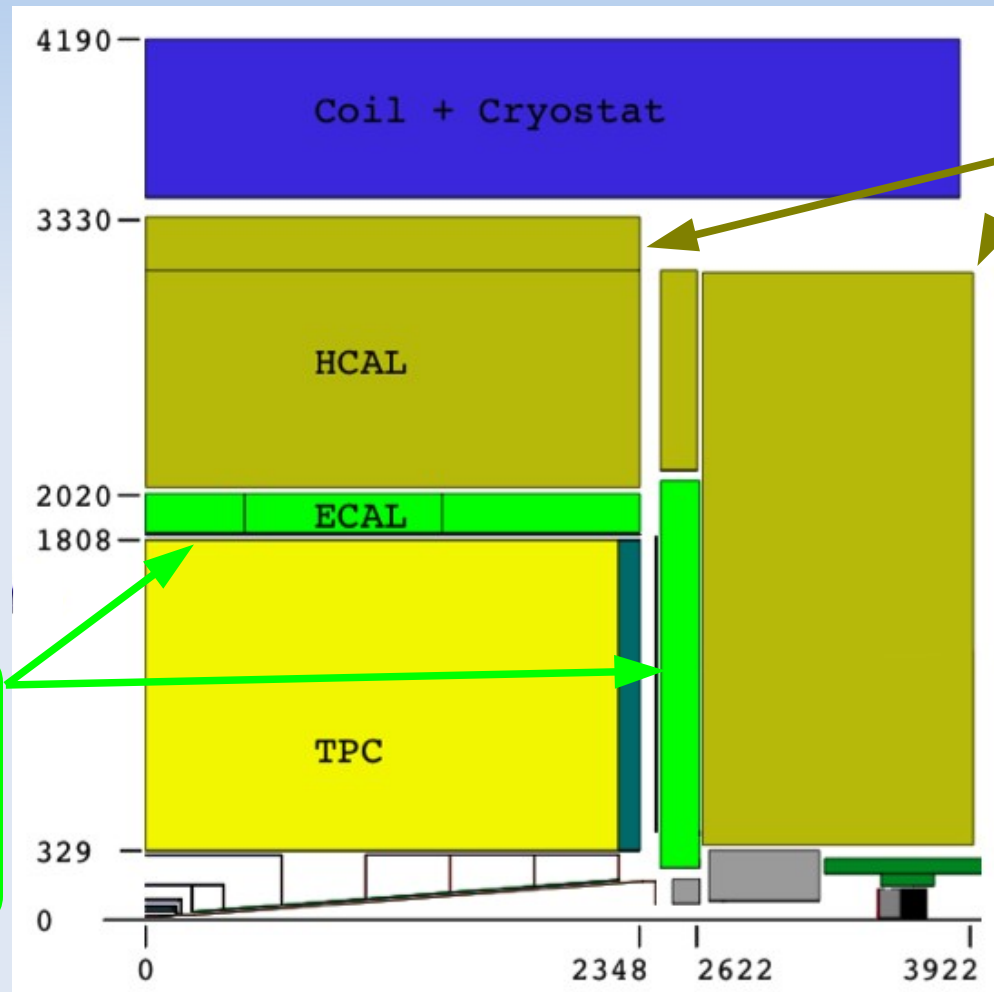
▶ ...

- Done for the baseline (Si-W ECAL + Scint HCAL)



# Dimensions & options

- $B = 3.5 \text{ T}$



HCAL

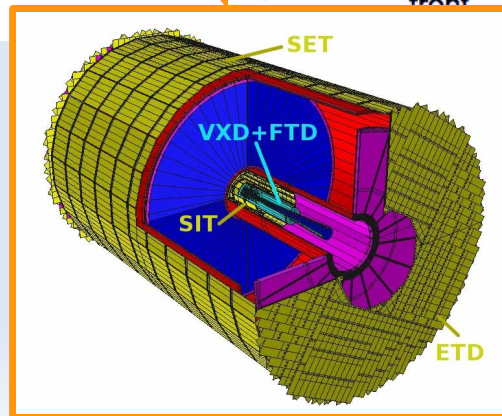
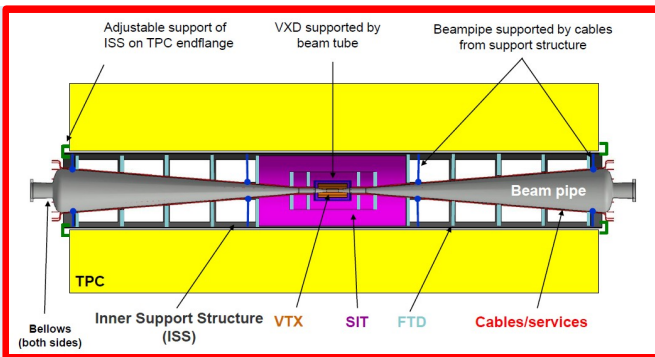
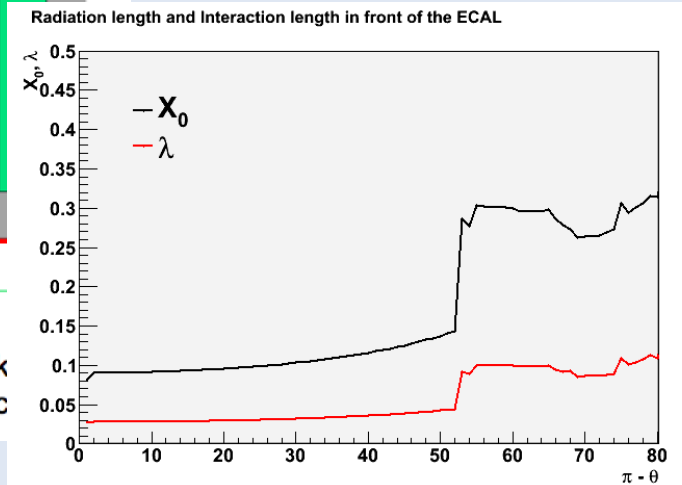
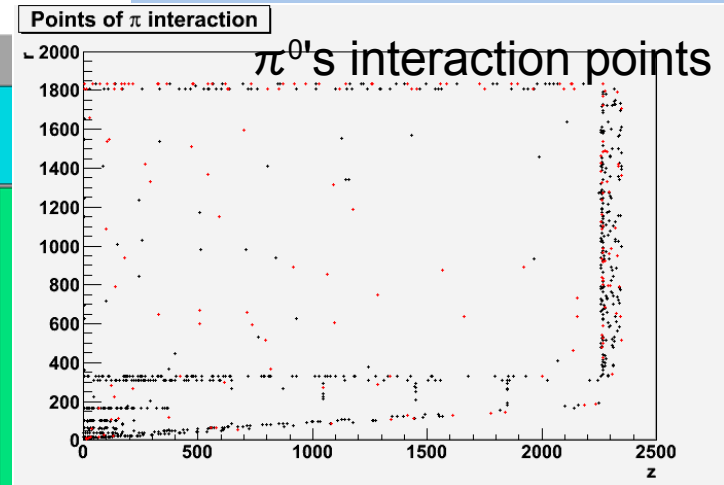
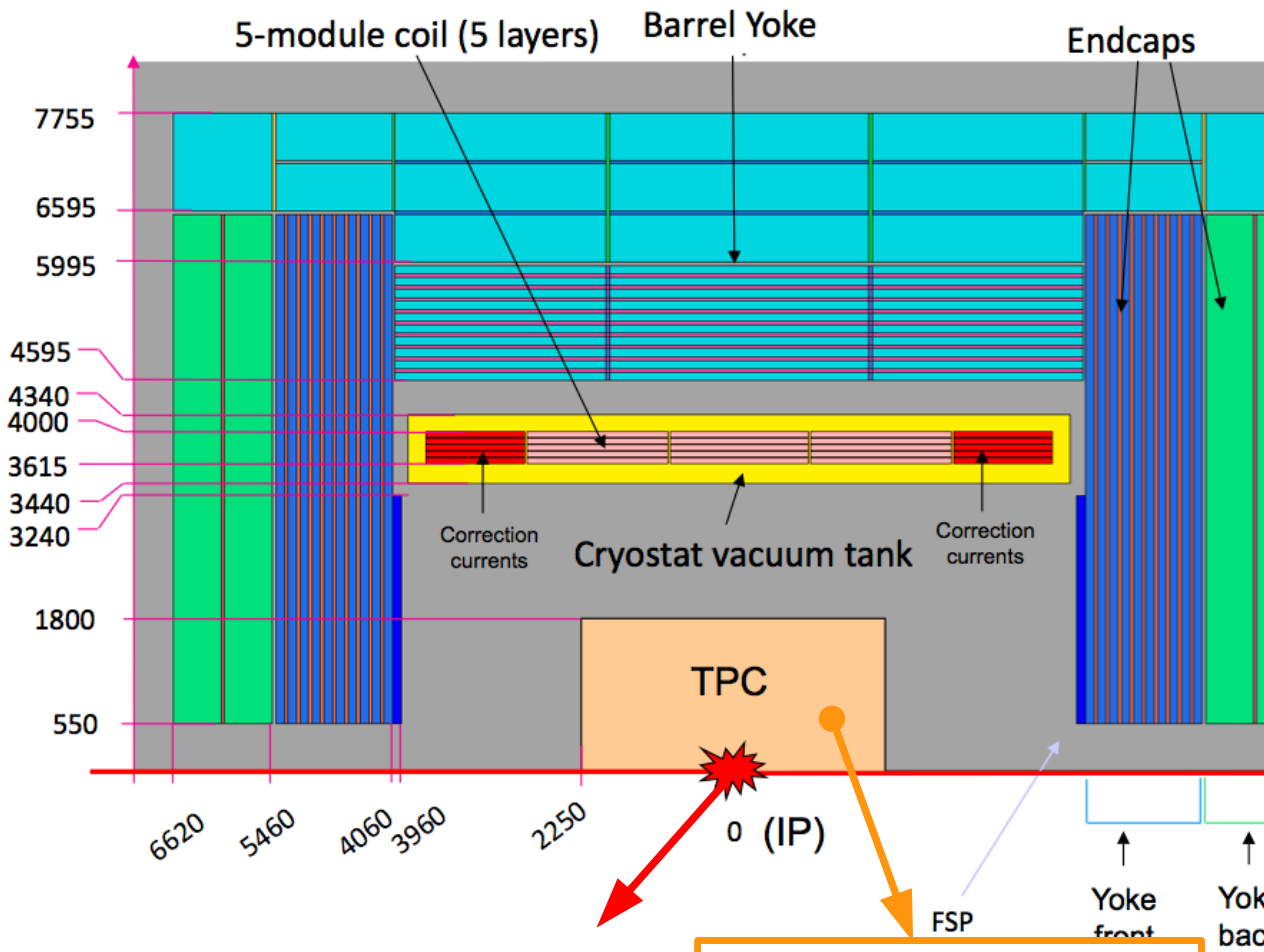
- Analog: Scint/Fe
- Digital: Rpc/Fe

ECAL

- Si/W
- Scint/W
- Maps: Digital



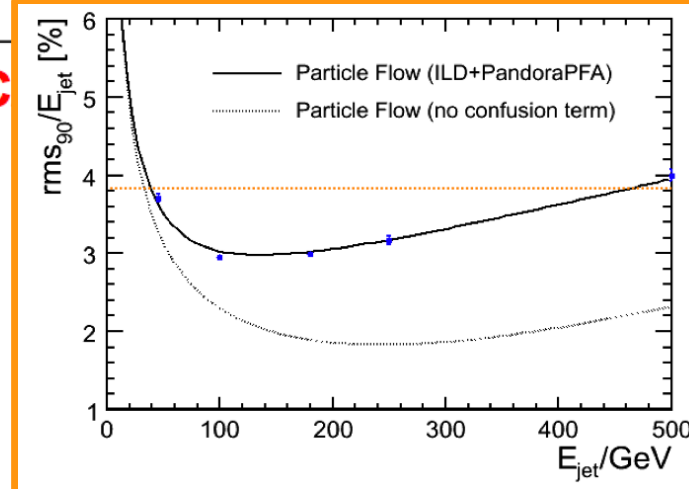
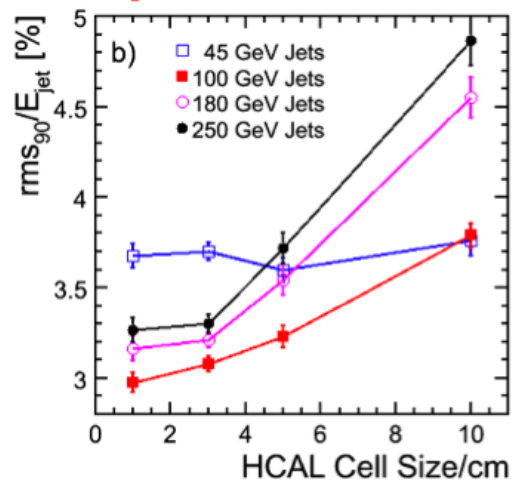
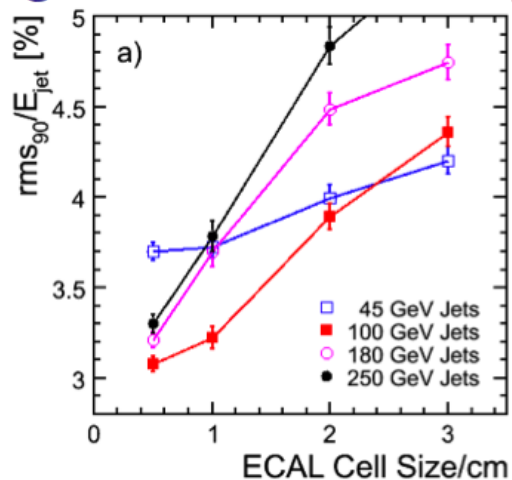
# Surroundings



# Optimisation

## PFA Optimisation: Calorimeter Segmentation

★ Starting from LDCPrime vary **ECAL Si pixel size** and **HCAL**



### ★ ECAL Conclusions:

- Ability to resolve photons in **current PandoraPFA algorithm** strongly dependent on transverse cell size
- Require at least as fine as **10x10 mm<sup>2</sup>** to achieve **4.0 % jet E resolution**
- Significant advantages in going to **5x5 mm<sup>2</sup>**
- For **45 GeV jets resolution dominates (confusion relatively small)**

### ★ HCAL Conclusions:

- For **current PandoraPFA algorithm** and for **Scintillator HCAL**, a tile size of **3x3 cm<sup>2</sup>** looks optimal
- May be different for a **digital/semi-digital RPC based HCAL**

Not yet complete

# Choice of calorimetry parameters

- Different central Calorimeter types envisaged

- ▶ All in CALICE collaboration

- ◆ Fwd calorimetry in FCAL collaboration



- Common feature

- ▶ High granularity & compact design

- ▶ aim at embedded readout, digitisation and storage electronics

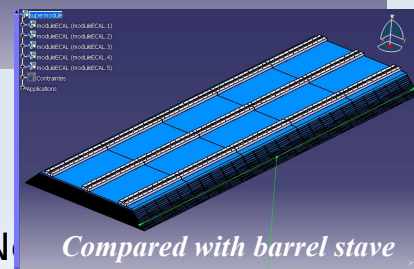
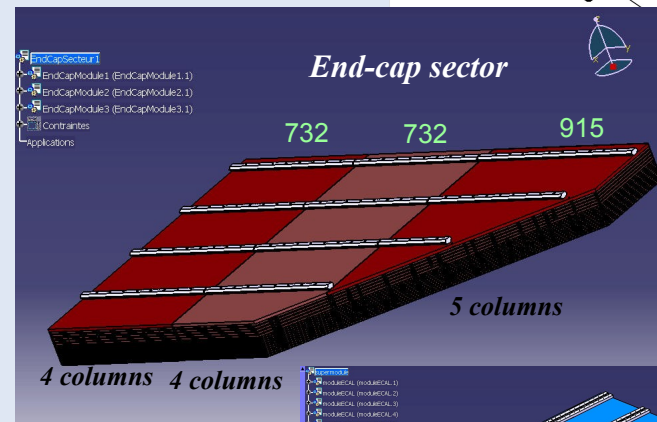
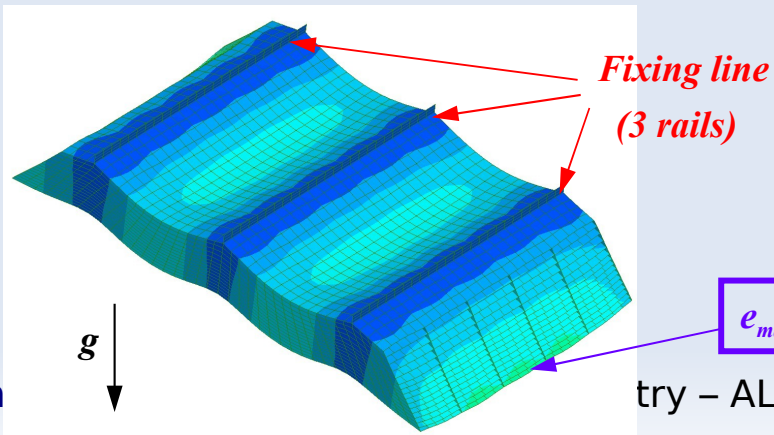
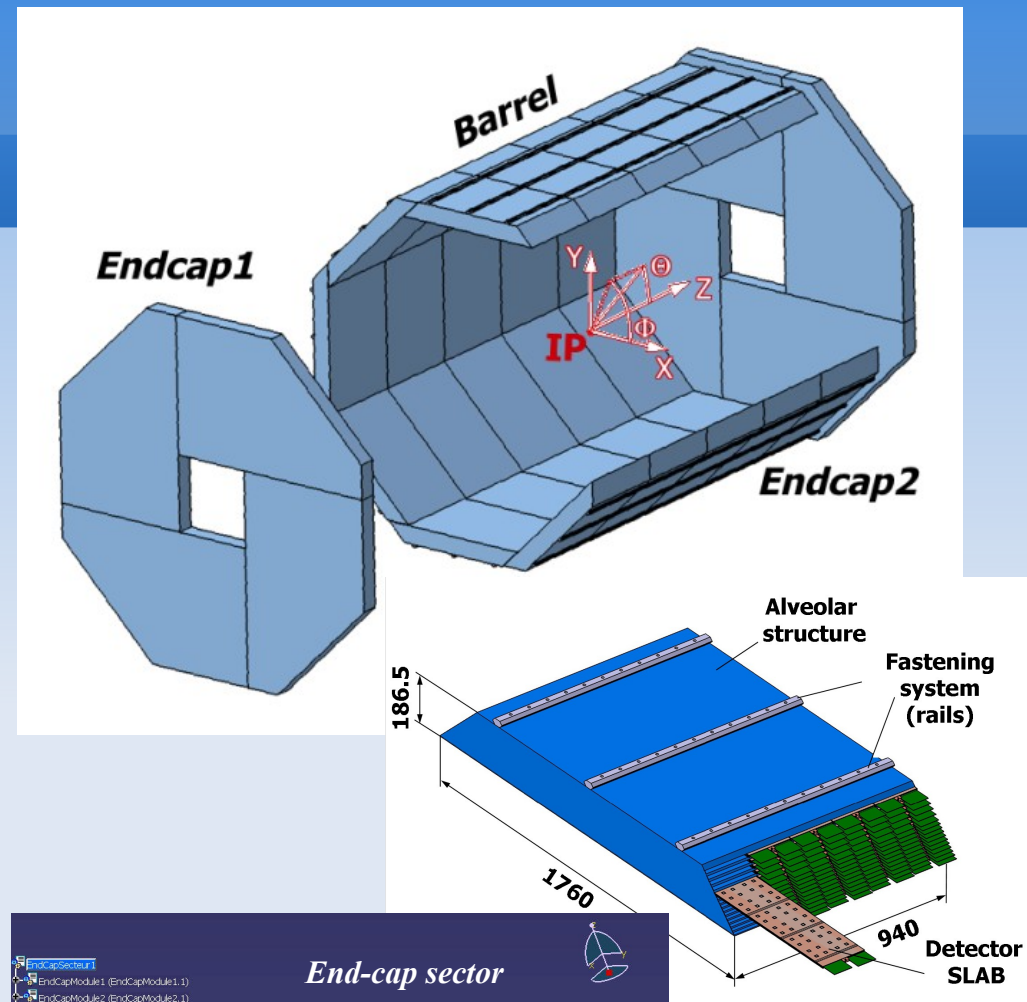
- ▶ Inter-spill readout

- ▶ power pulsing

- ▶ common DAQ

# ECAL structure

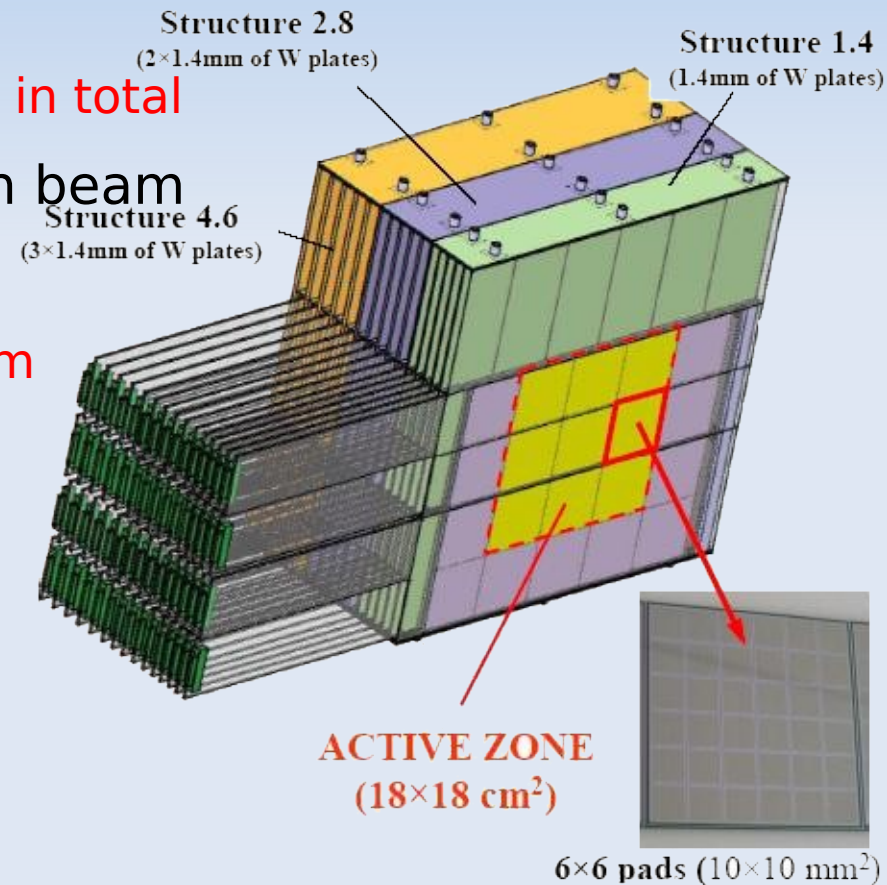
- Barrel: 5 octagonal wheels
  - $R_{\min} = 1808 \text{ mm}$ ;  $R_{\max} = 2220$
  - Width = 940mm
- End-caps: 4 quarters
  - $\varnothing_{\min} = 800 \text{ mm}$
- Carbone / Tungsten structure
  - filled with Si or scintillators (option MAPS/DECAL)
- Extensive mechanical simulation & tests



Compared with barrel stave



- Structure
  - ▶ 20 layers of 2.1 mm ( $0.6X_0$ ) W  
+ 9 layers of 4.2mm ( $1.2X_0$ ) W
  - ▶  $5 \times 5$  mm<sup>2</sup> granularity of Si  $\sim$  108 M cells in total
- $10 \times 10$  mm<sup>2</sup> physics prototype tested in beam
  - ▶ FLC\_PHY4=3 chips with analog readout
  - ▶ Energy resolution measured in test beam  
 $\sim 16.6\%/\sqrt{E(\text{GeV})} \oplus 1.1\%$   
with S/N ratio of 7.5 for a mip signal
  - ▶ CERN 2006, 2007  
FNAL 2008, 2009
- Critical points
  - ▶ power pulsing
  - ▶ Si sensors price (3000 m<sup>2</sup>)



*Too many to be fair... Check R. Poeschl Talk for more details*

- Square events at high E (Guard Ring X-talk)
- Excellent long term stability ( $\sigma_{\text{mip}}/\text{mip} \sim 1/50$  on 2 yrs)
- Good agreement EM Sim/Data ( $\Leftrightarrow$  understanding of detector)
- Optimization of E reconstruction

- ▶ Correction of dead regions
- ▶ pixel counting & weighting

- ◆ layer optimisation

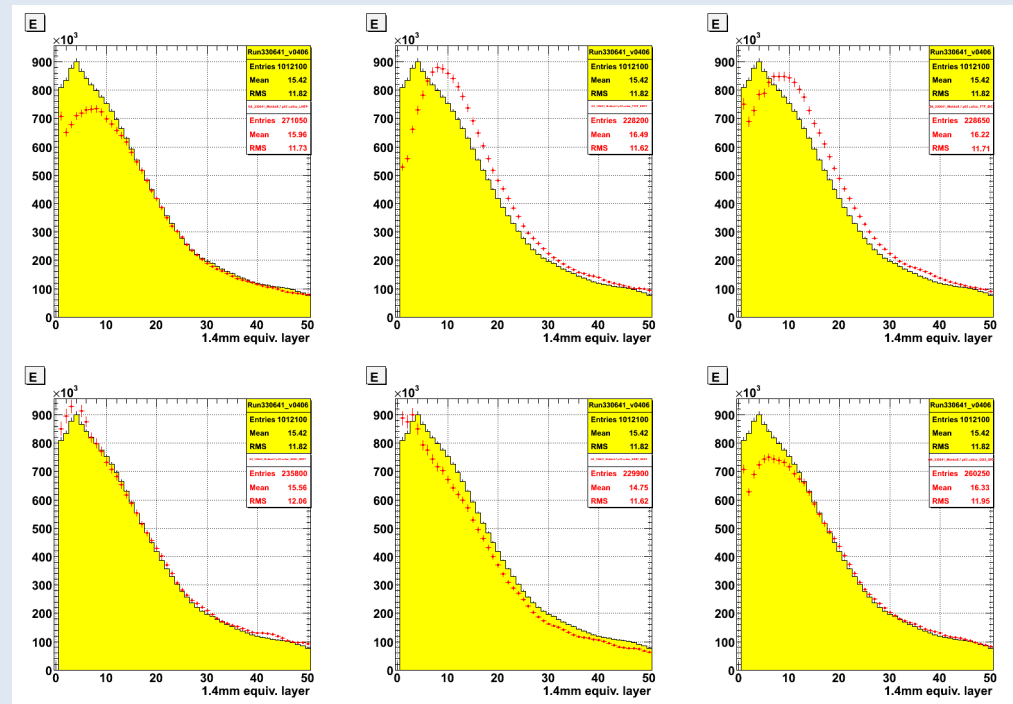
- Data analysis on going:

- ▶ Reconstruction of shower shapes

- ◆ improved position & direction rec.

- ▶ Hadrons in ECAL

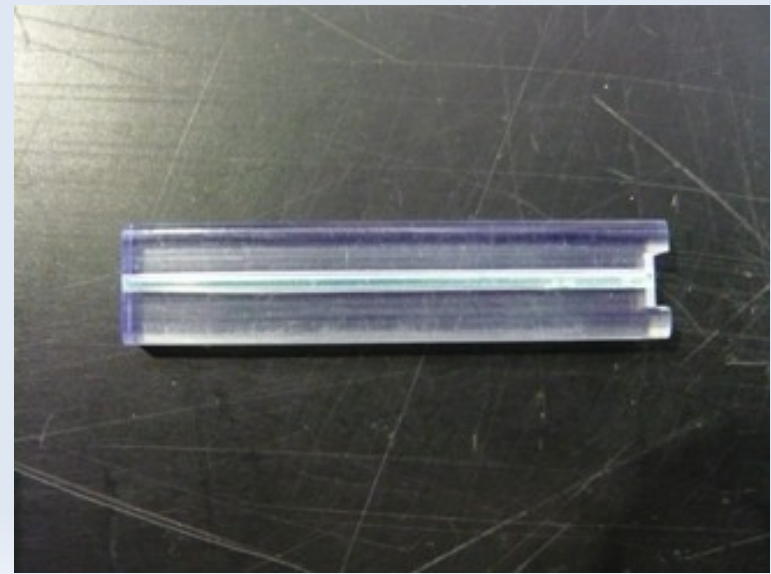
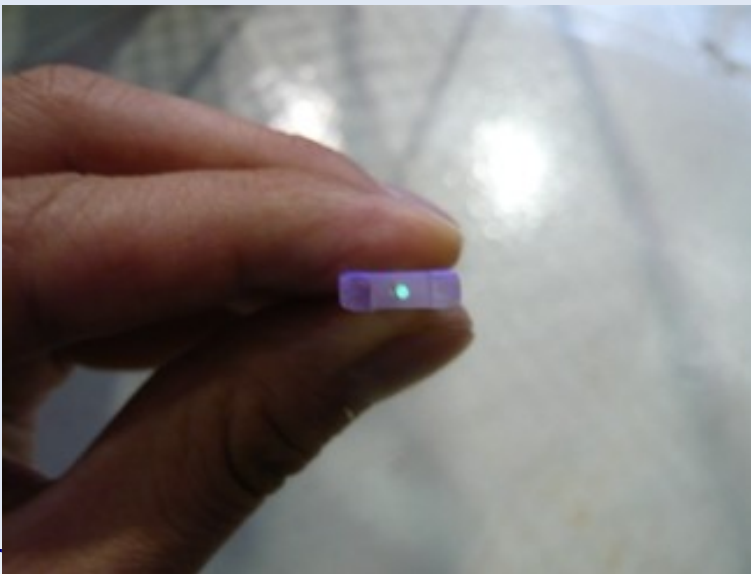
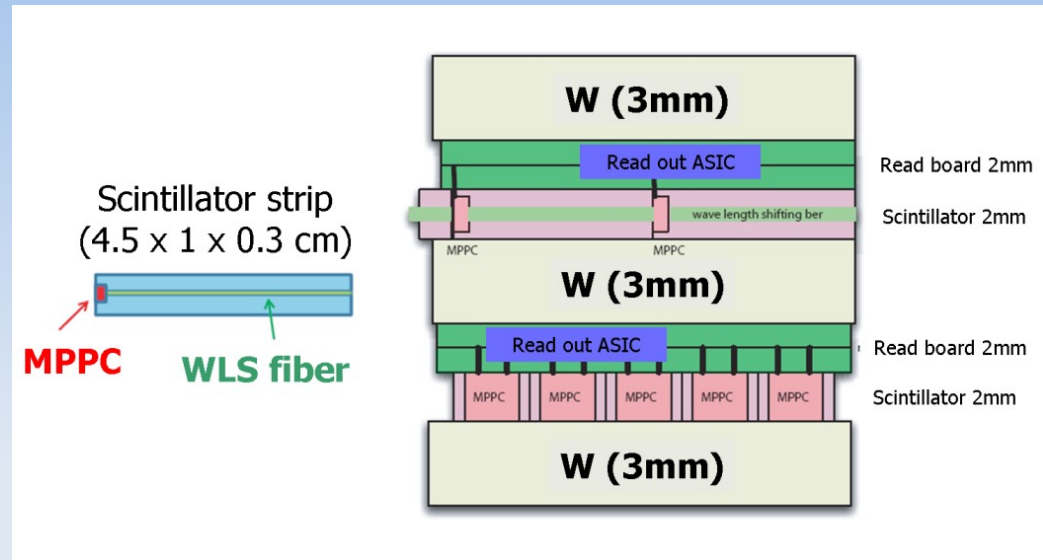
- ◆ Geant testing with Tungsten



# Scint/W ECAL (1)

## ILD Structure

- ▶ 24 layers of 3 mm W  
2 mm scintillator + 2 mm r.o.
  - ◆  $21X_0$  in total
- ▶  $10 \times 45 \text{ mm}^2$  scintillator strips to reduce # of ch ( $\sim 107$ )
- ▶ Wavelength shifter fiber and multi-pixel photon counter (MPPC) readout
- ▶ Energy resolution  $\sim 14\%/\sqrt{E(\text{GeV})} \oplus 2\%$



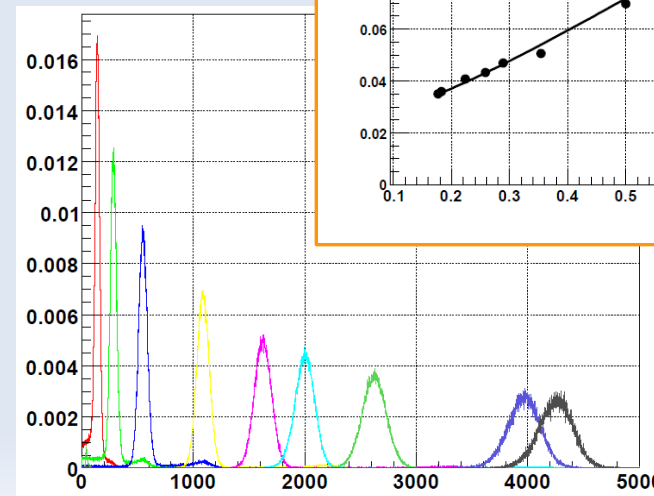
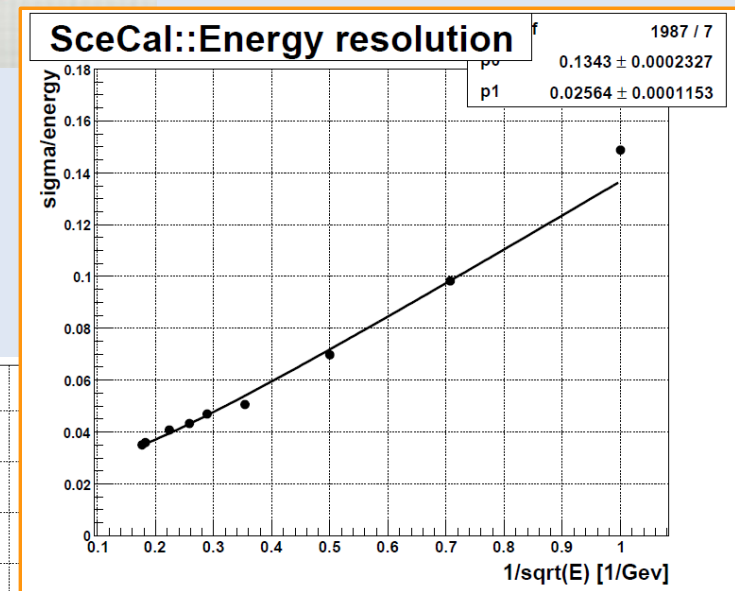
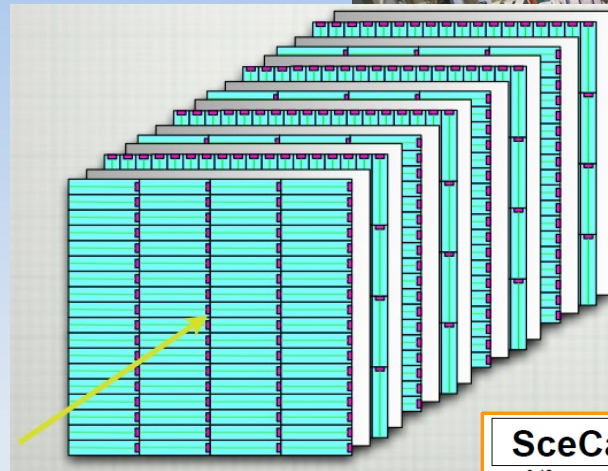
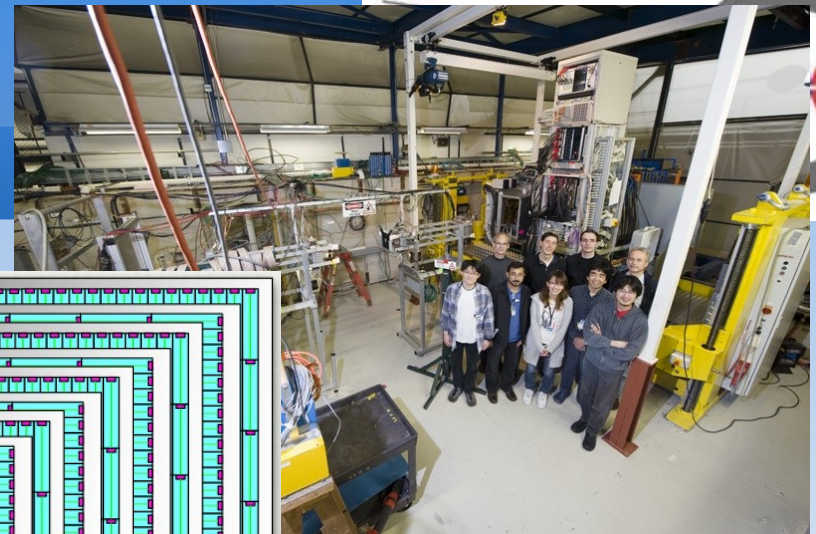
# Scint/W ECAL (2)

## ■ Physics prototype

- ▶ tested in summer 2009 at FNAL
  - ◆ 30 layers of 72 strips
  - ◆ 3.5mm W
- ▶ MPPC Correction
  - ◆ temperature
  - ◆ saturation
  - ◆ Slightly Improved resolution
- ▶ Reconstruction code

## ■ MPPC Developments

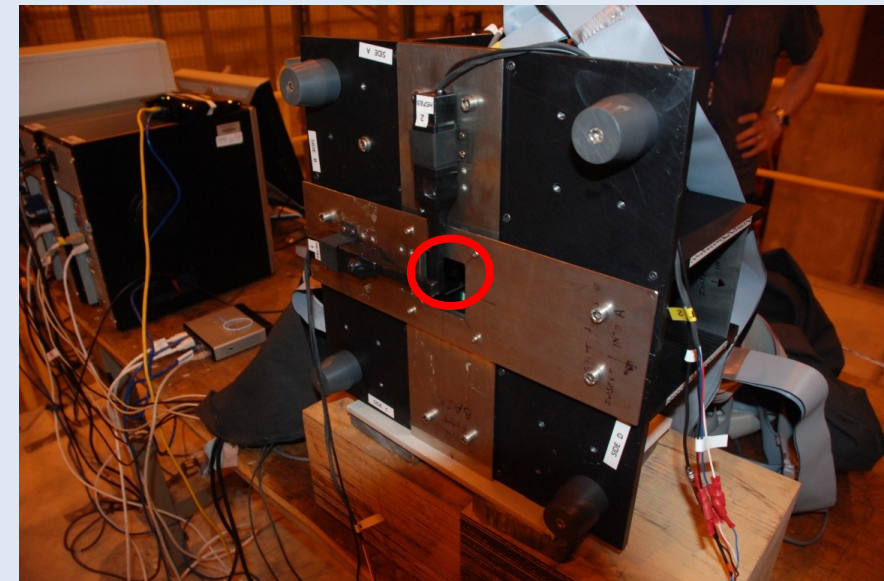
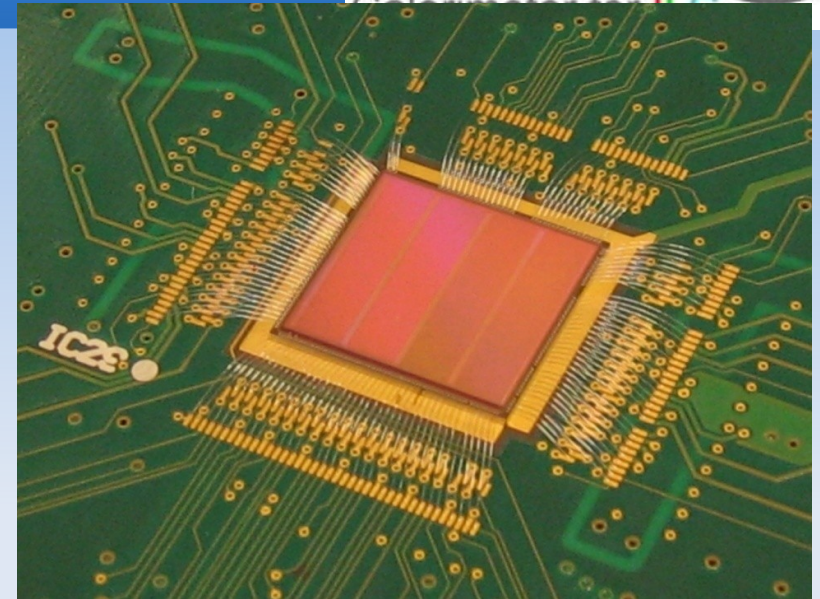
- ▶ Irradiation tests
  - ◆ ~OK < 60 Gy in  $\gamma$ ,  $10^8$  n/cm<sup>2</sup>
- ▶ Stability
- ▶ Simulations





# DECAL (MAPS) option

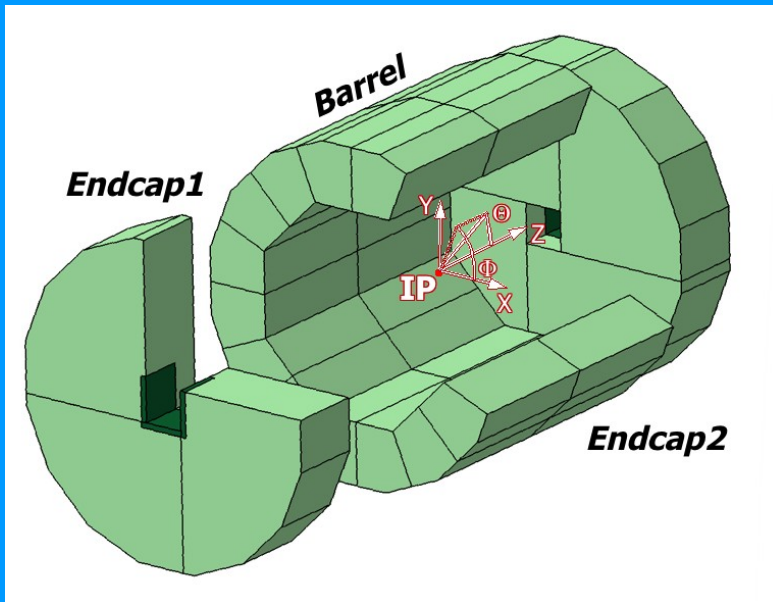
- Ultimate Spatial resolution
  - ▶  $50 \times 50 \mu\text{m}^2$  pixels
    - ◆ TERA Pixel detectors
  - ▶ TPAC readout chip  
v1 =  $168 \times 168$  pixels;  
 $79.4 \text{ mm}^2$
- Expected resolution (pixel counting)
  - ▶  $13\%/\sqrt{E(\text{GeV})} \oplus 1\%$
- Status:
  - ▶ successful CERN TB of 6 sensors summer 2009
  - ▶ New SPiDeR collaboration
  - ▶ Physics prototype planned for 2012
- Critical points
  - ▶ Power consumption, integration services, price, ...



# Geometries for the HCALs

- Sensor agnostic ▶ 48 layers of 20mm SS  $\rightarrow 5.7 \lambda_1$  (6.6 with ECAL)

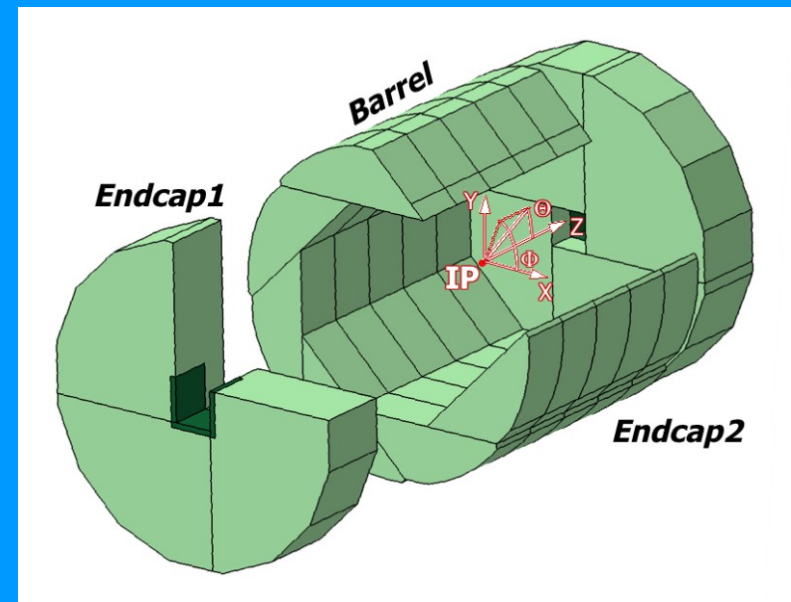
DESIGN 1 (TESLA)



Better access to electronics

Larger radius

DESIGN 2 ("a la Videau")

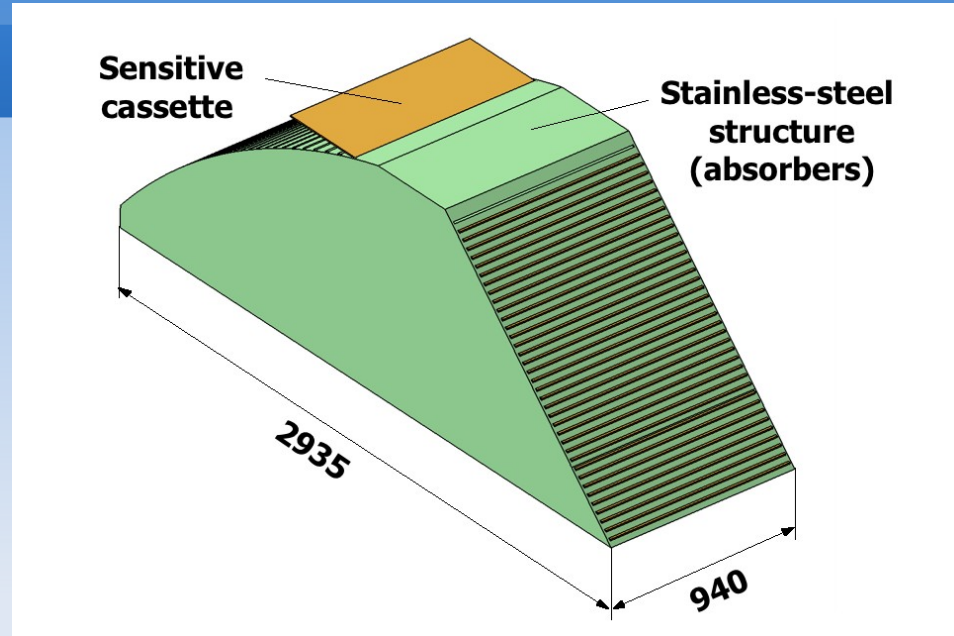
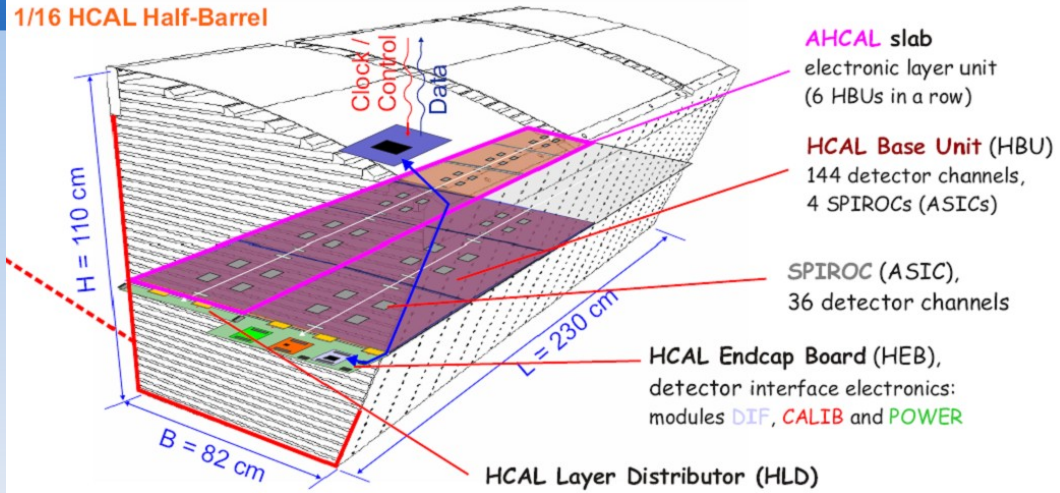


better hermiticity

mechanical rigidity

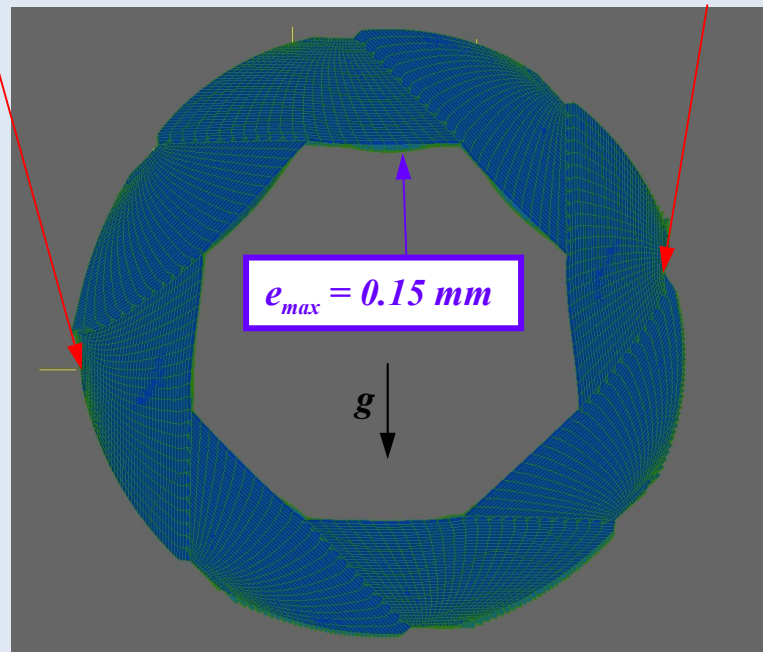
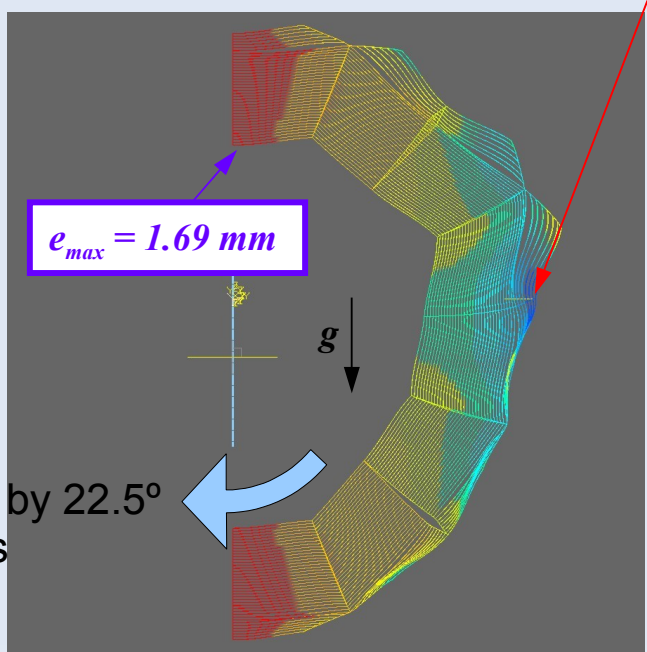


1/16 HCAL Half-Barrel



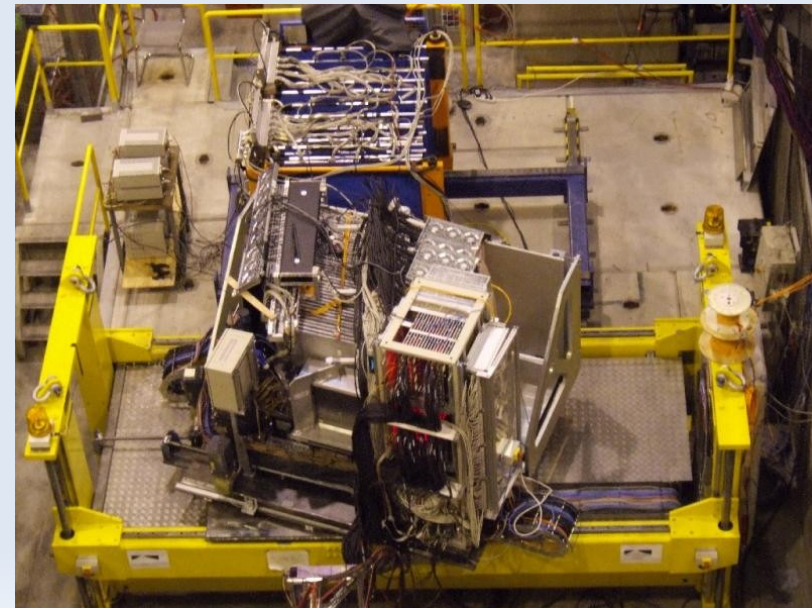
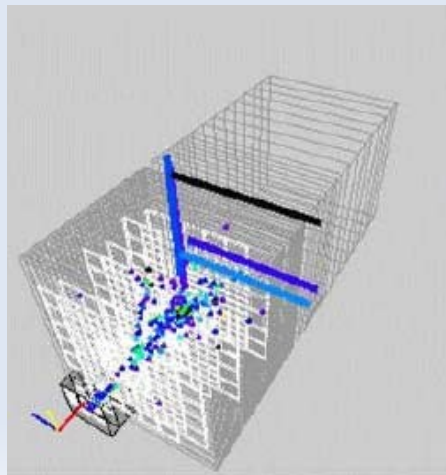
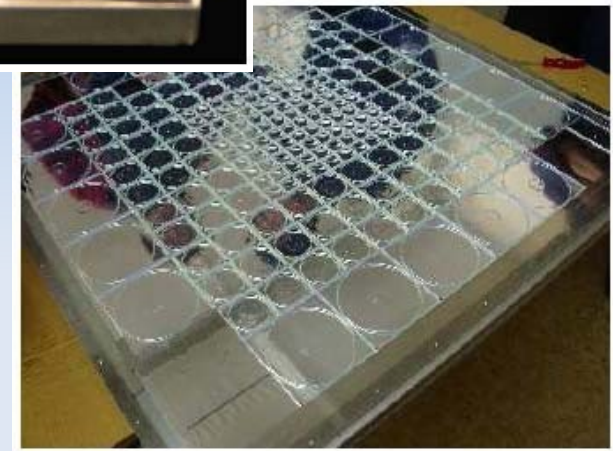
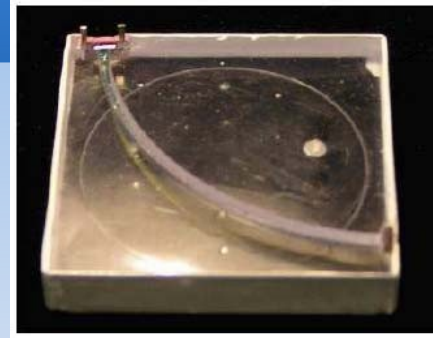
*Fixing lines*

*Fixing lines*



# AHCAL: Scint/Fe with SiPM

- $3 \times 3 \text{ cm}^3 \times 3 \text{ mm}$  scintillator tiles
  - ▶ WLS fiber readout by SiPM (studies without)
  - ▶ Energy resolution  $\sim 49.2\%/\sqrt{E(\text{GeV})} \oplus 2.3\%$
- Physics prototype
  - ▶ 38 layers Scint + 2cm SS  $\rightarrow 5 \lambda_{\text{had}}$
  - ▶ extensively tested with ECAL + TCMT
    - ◆ 2006  $\rightarrow$  2008
- Critical elements
  - ▶ price of SiPM, calibration

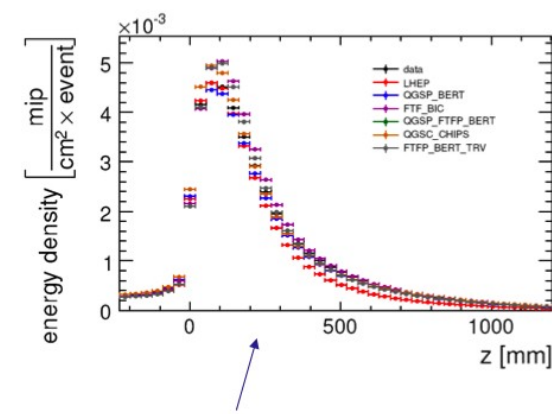
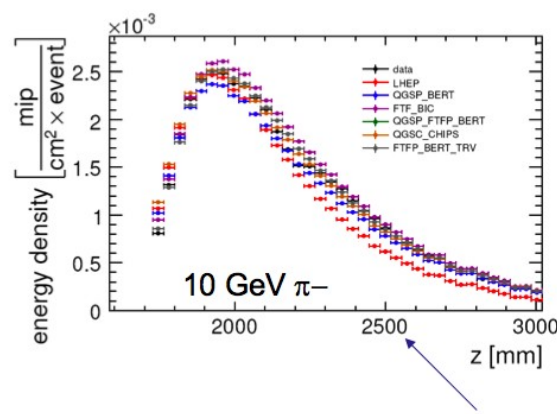




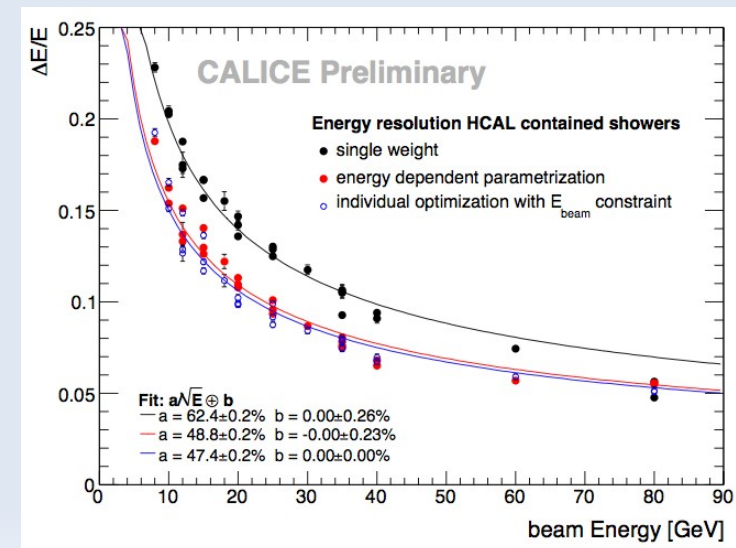
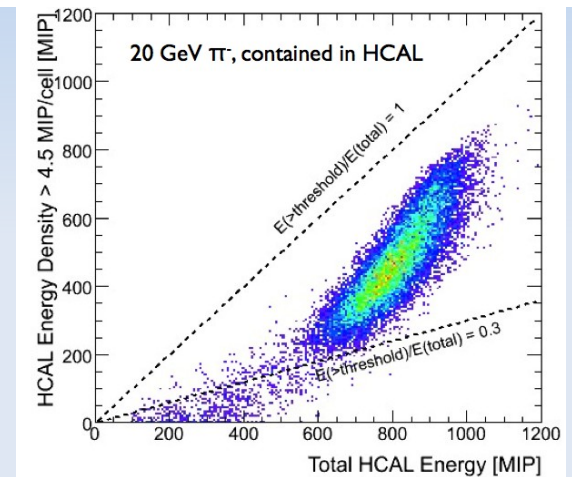
# AHCAL results

Many many results...  
See Angela Lucaci-Timoce talk

- Understanding of calibration
  - ▶ LED system
  - ▶ Scint + SiPM t<sup>0</sup> & saturation correction
- Good overall agreement Data/MC
  - ▶ EM response 10-50 GeV
  - ▶ HAD response
    - ◆ Test bench for Geant4
    - ◆ Shower start & profile
    - ◆ Shower spatial separation
    - ◆ Leakage corrections
- Resolution improvement by weighting technique
- Calibration from track segments



Presents longitudinal profiles from detector start and from shower start for various energies and MC models



# DHCAL : semi-digital gaseous

- Glass Resistive Plate Chamber (GRPC) with  $1 \times 1 \text{ cm}^2$  readout pads

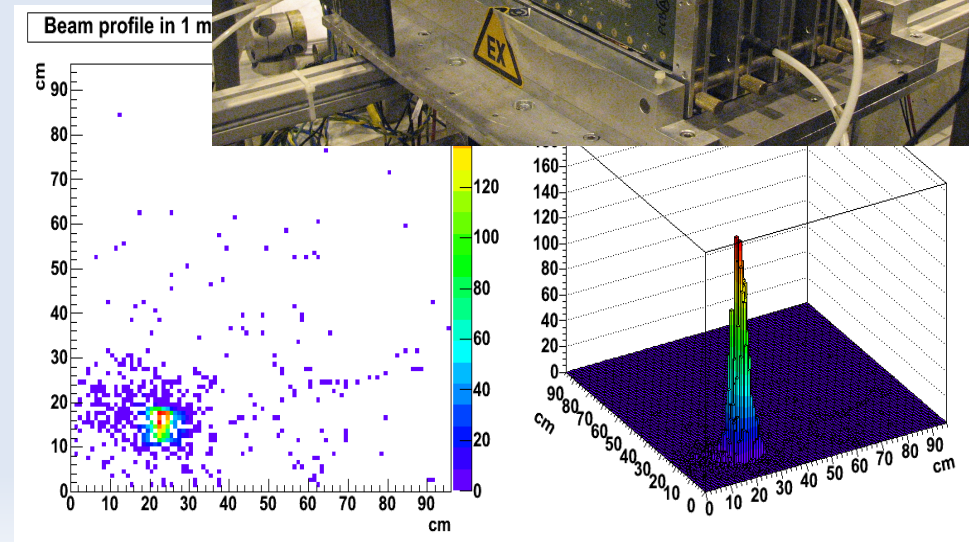
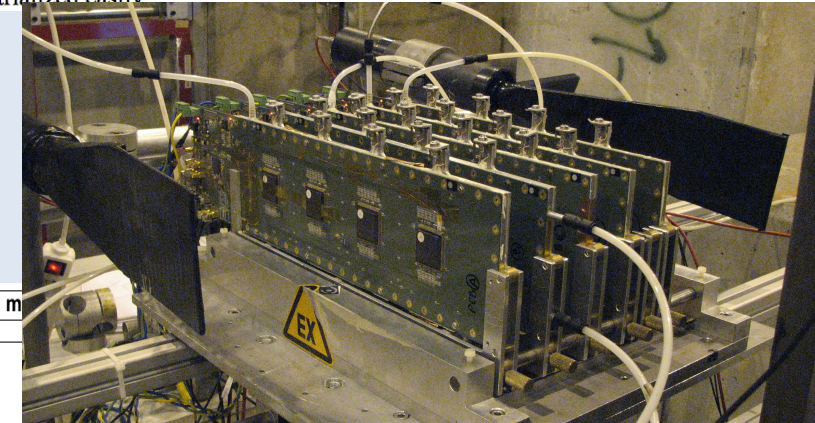
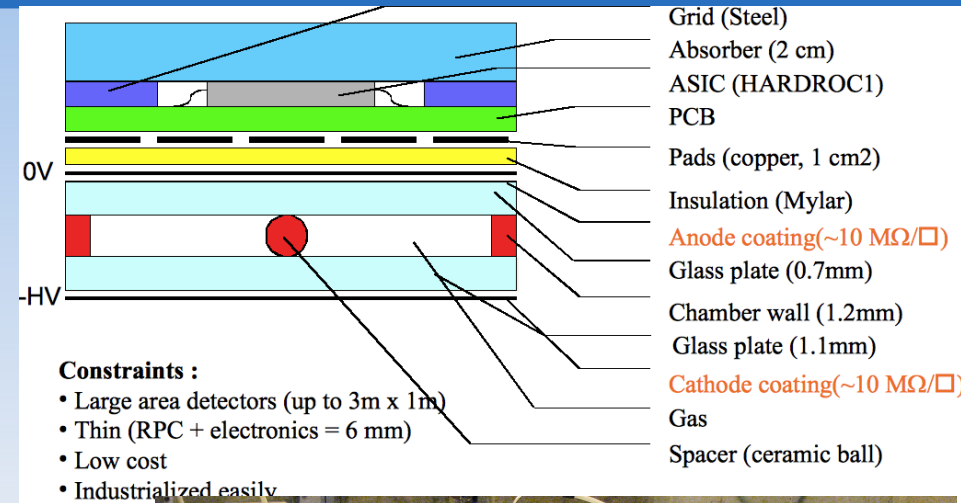
- ▶ Semi-digital (2bits) readout
- ▶ Expected raw  $\sigma_{Ej}/Ej \sim$  analogue one

- Prototypes chambers

- ▶ small ( $8 \times 32 \text{ cm}^2$  and large  $1 \text{ m}^2$ ) RPC tested
- ▶ with embedded electronics (HARDROC1)

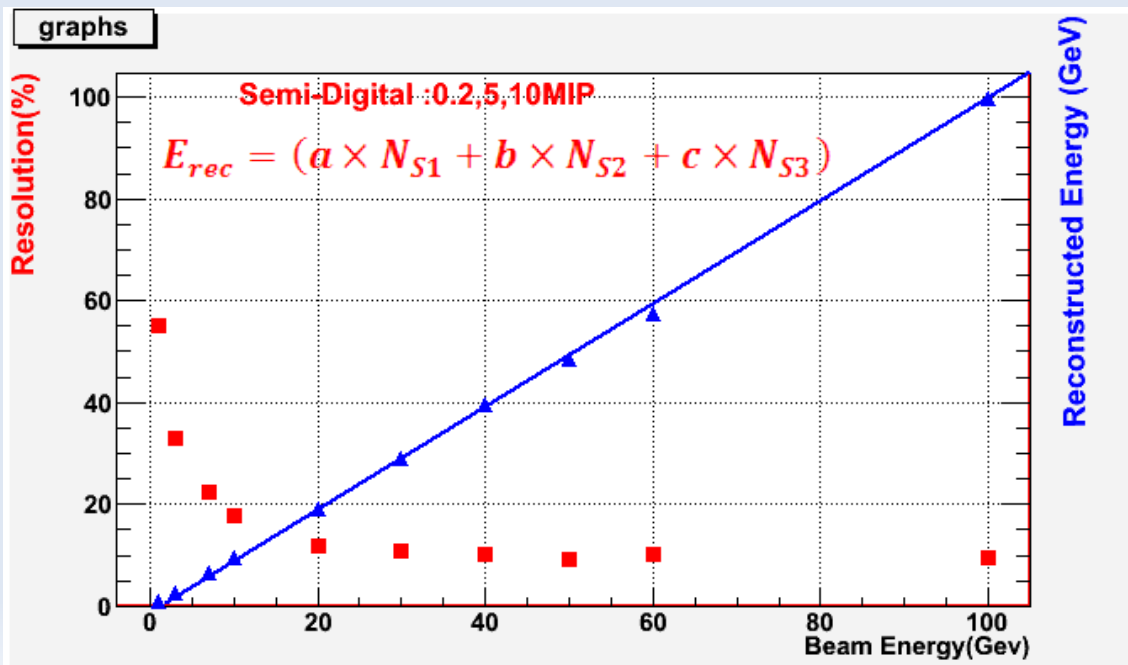
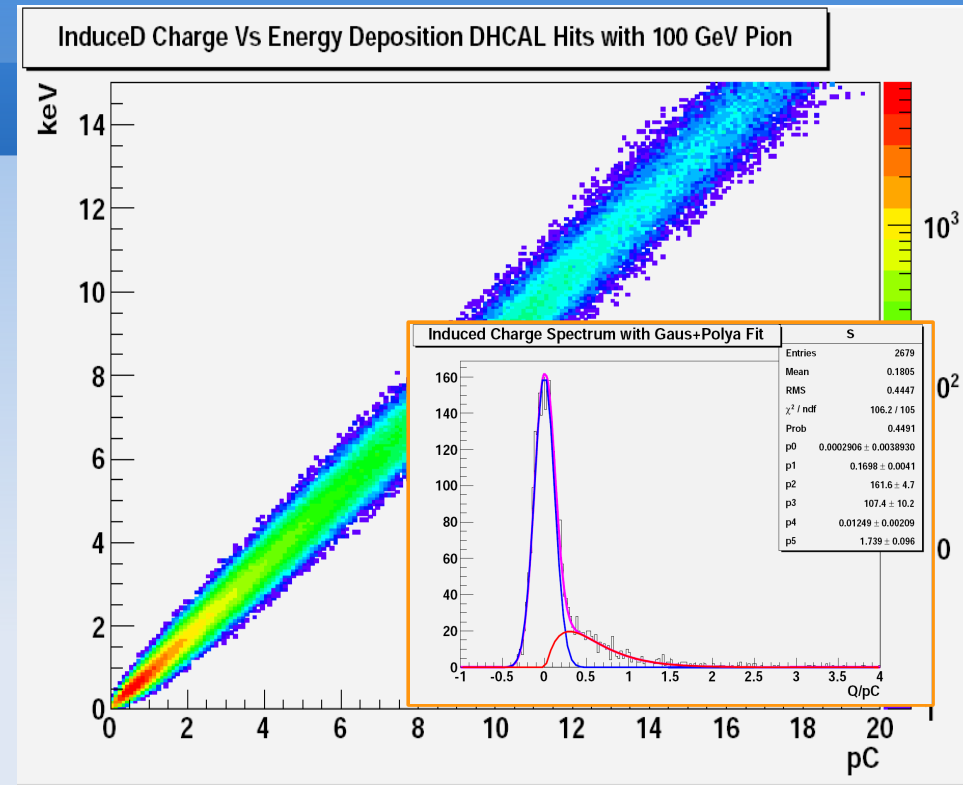
- R&D

- ▶ on semi-conductive paints
  - ◆ stability & industrial painting
- ▶ On (fast) semi-conductive glass
- ▶ Gas distribution
  - ◆ and replacement for Isobutane



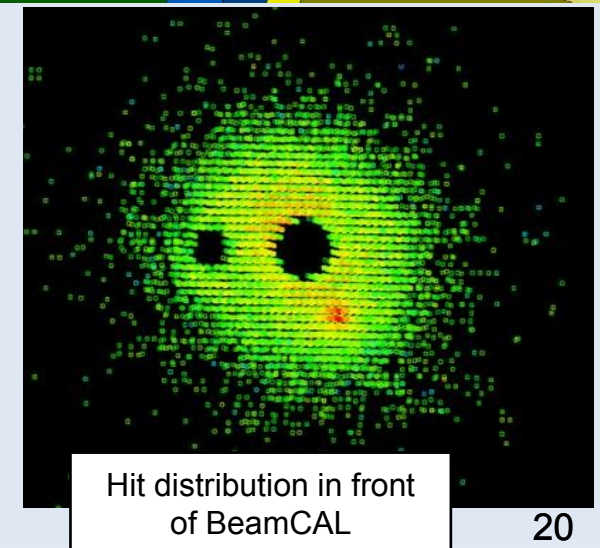
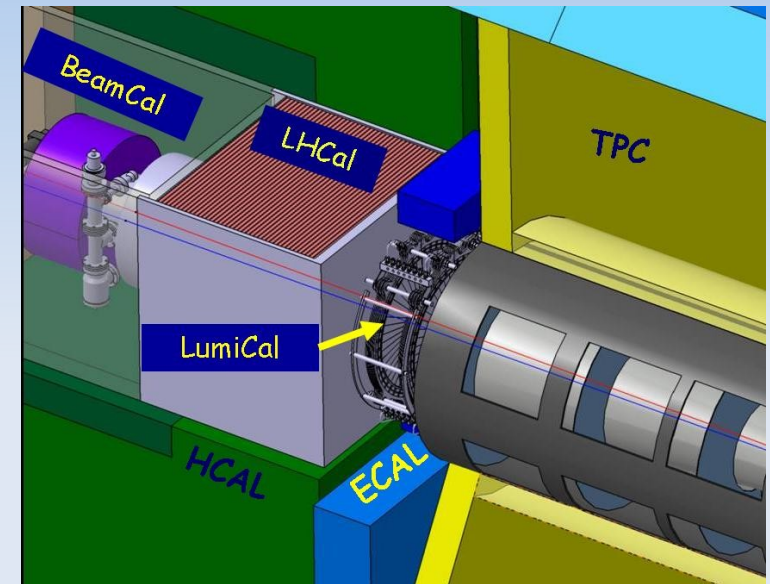
# SDHCAL (2)

- Simulation
  - ▶ Digitisation : response from RPC
- Reconstruction
  - ▶ Efficiency & multiplicity
  - ▶ Energy from hits
    - ◆  $\sum W_i \times N_i$  ; Neural network
  - ▶ Simulated hadronic response



# Forward Detectors

- LumiCAL
  - ▶ Si/W
  - ▶ 32 - 74 mrad
  - ▶ Luminosity measurement accuracy of  $< 10^{-3}$
- BeamCAL
  - ▶ 5 - 40 mrad
  - ▶ Hit by e+e- pair-background caused by beam-beam interaction
  - ▶ Si, GaAs, or diamond - W sandwich
- Pair-monitor
  - ▶ Placed in front of BeamCAL
  - ▶ Measure beam shape from the distribution of Pair-background
  - ▶ Si pixel detector
- LHCAL
  - ▶ Locates after LumiCAL
  - ▶ Si/W sandwich,  $4\lambda_1$



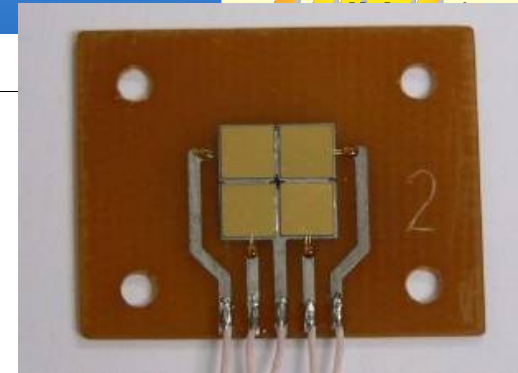
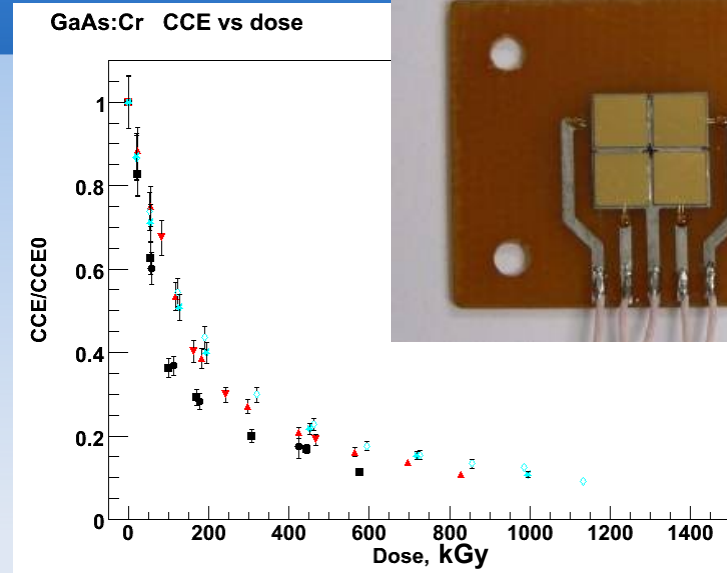


# FCAL recent developments



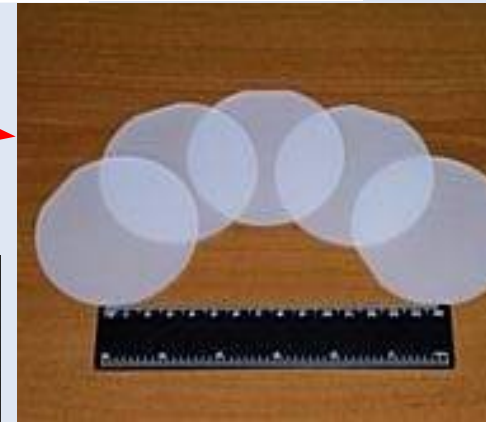
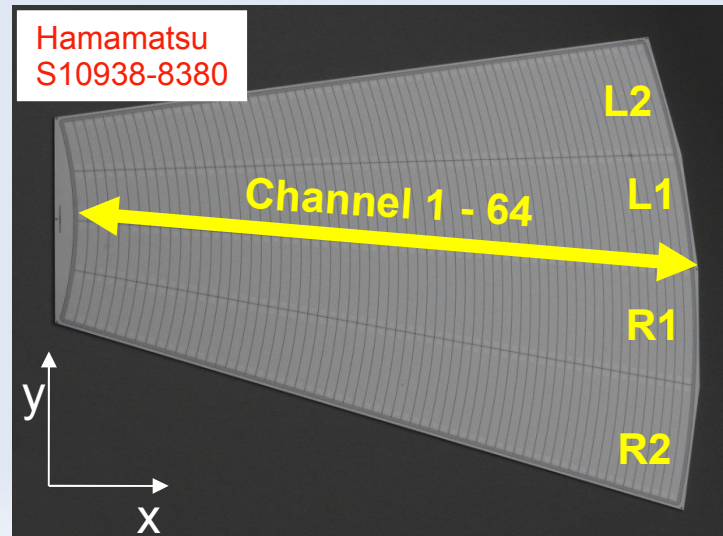
## ■ BeamCal Sensor Prototyping

- ▶ n-type GaAs(Te,Sn)+Cr
  - ◆ made by SIPT (Tomsk)
  - ◆ OK  $\leq 500$  kGy (10 MeV  $e^-$ )
- ▶ sCVD diamond (E6),  $5 \times 5 \times 0.3$  mm<sup>3</sup>
  - ◆  $\leq 10$  MGy (<sup>90</sup>Sr)
- ▶ Sapphire: Single crystal, 1x1 cm<sup>2</sup>
  - ◆  $\sim 30$  % of the initial charge collection eff. after 12 MGy
- ▶ No choice done so far



## ■ LumiCal

- ▶ High resistivity n-type Si
  - ◆  $10,8 \times 4 \dots 12$  cm<sup>2</sup> (6 Inch Wafers)
  - ◆ I(V) & C(V) meas.  $\rightarrow$  successful



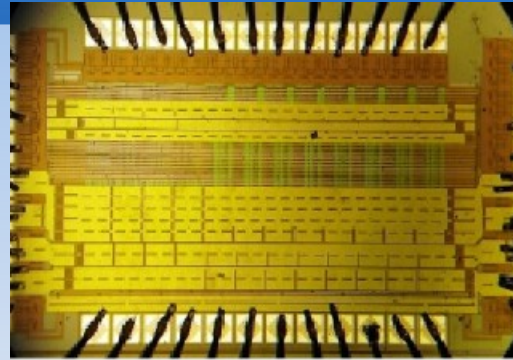
# FCAL recent developments(2)

- ASIC Development and Test

- ▶ BeamCal

- ▶ LumiCal

- ◆ 8 channel preamplifier, lab tests, matches the requirements (power consumption, noise, lin.)
    - ◆ 1 ch. 10 bit ADC, 35 MHz on test → multichannel



- Test beams

- ▶ with various sensors: scheduled for 2010

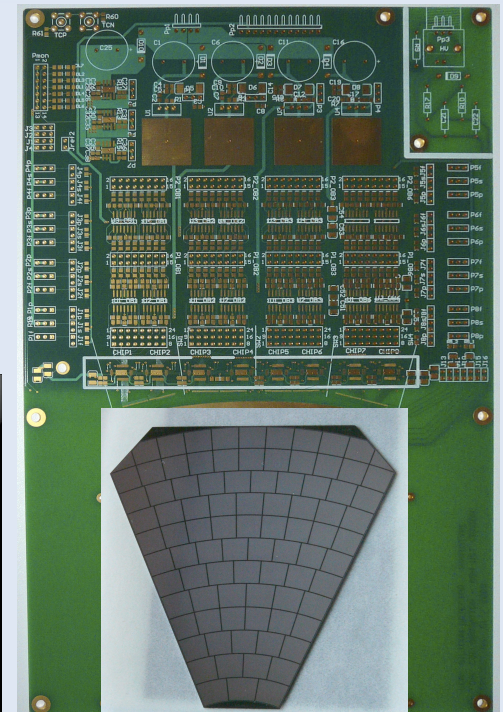
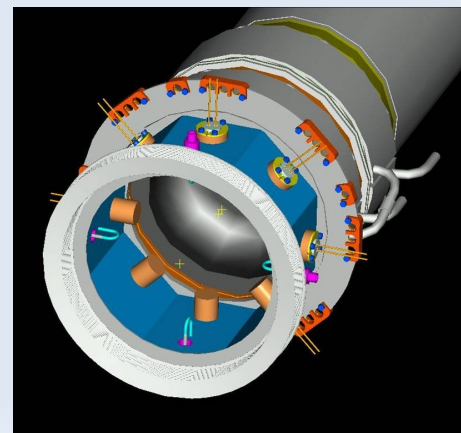
- ▶ diamond sensor tested in bunched e- beam

- ◆ beam profile, no EMI

- Applications as beam monitors:

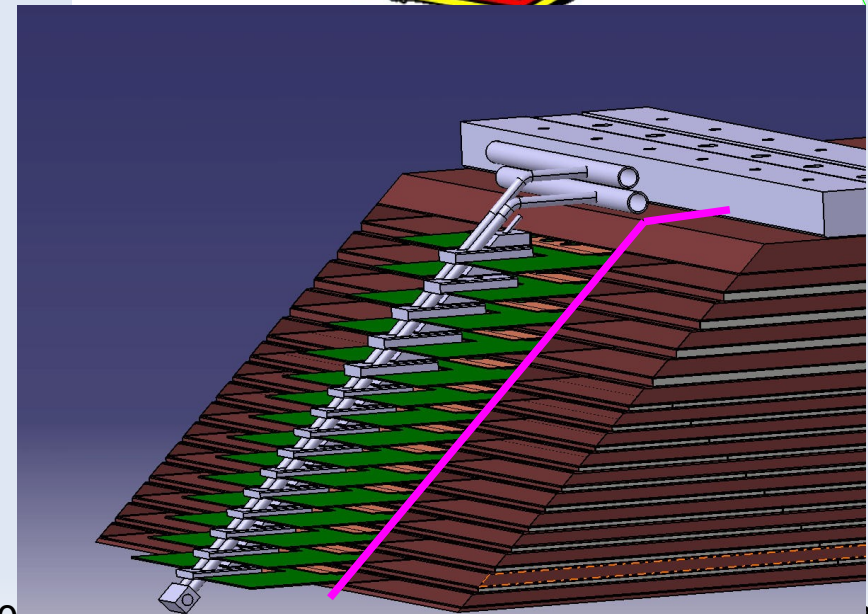
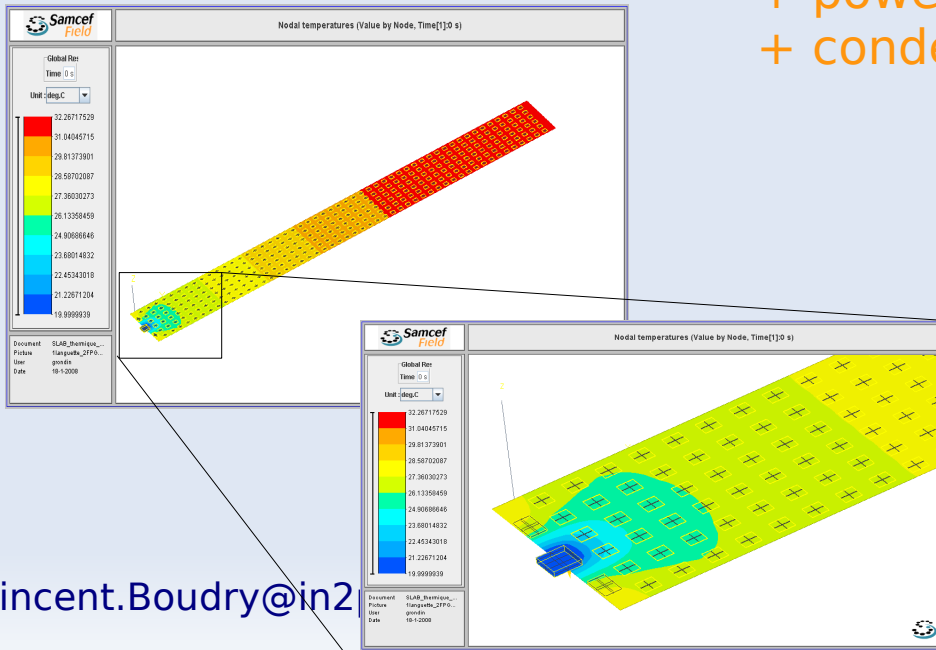
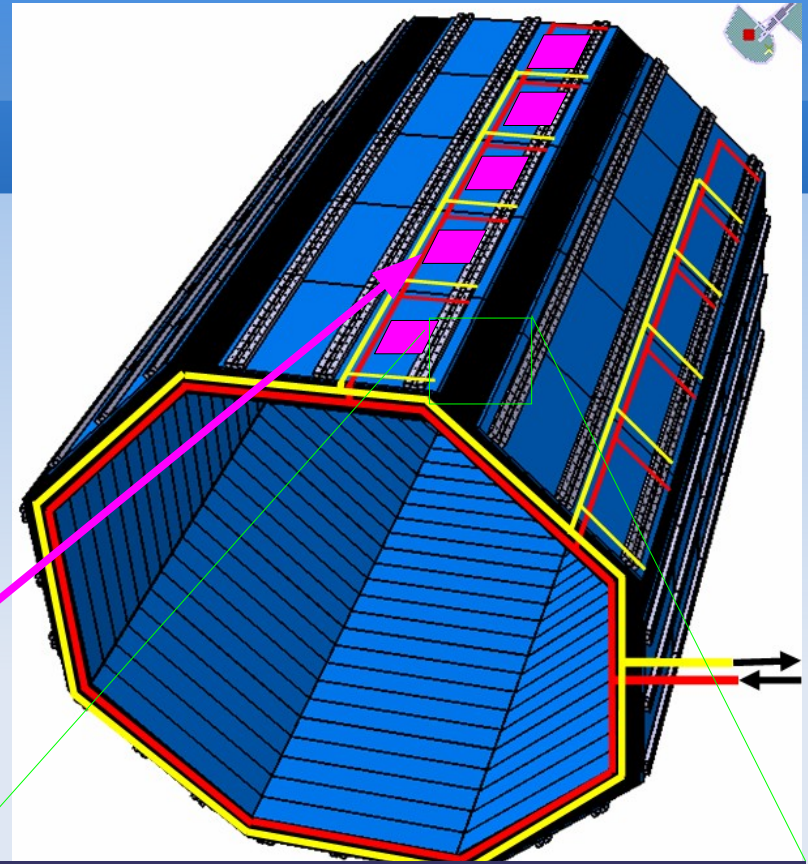
- ▶ 4 diamond & 4 sapphire sensors for FLASH

- ▶ CMS : BCMF1

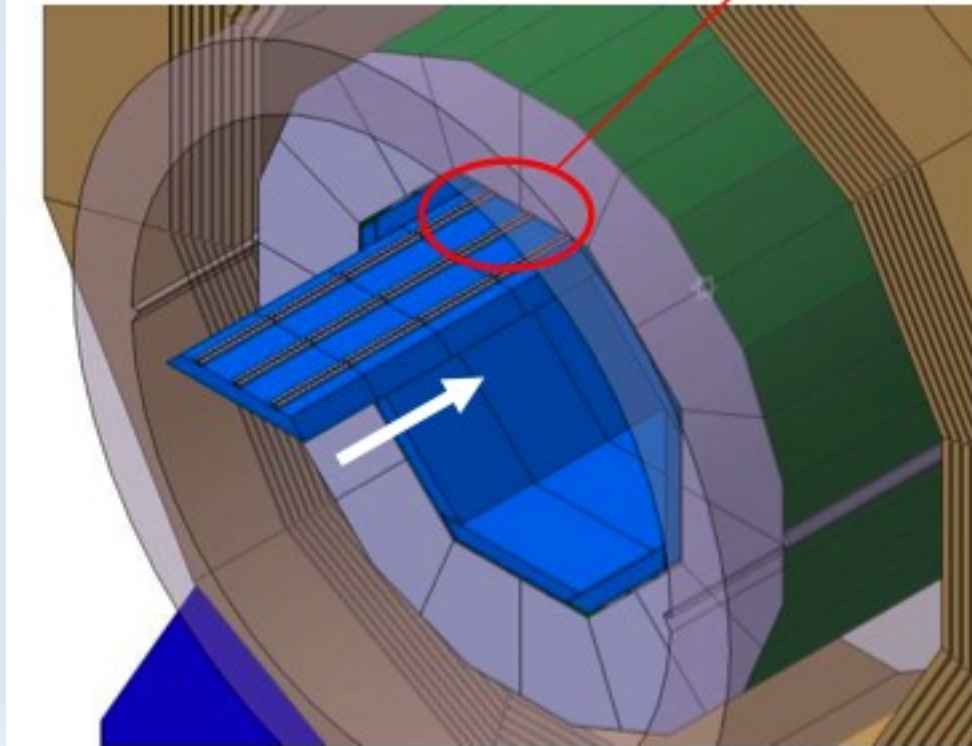
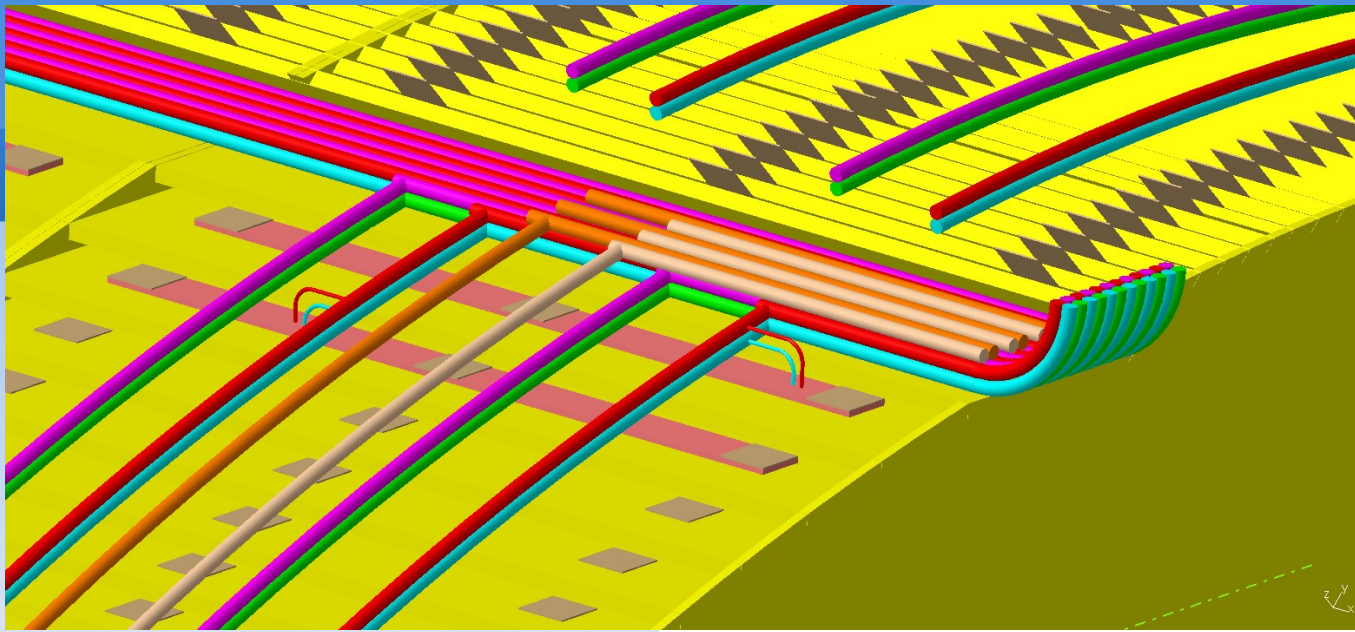


# Integration & services

- Services & cabling
  - cooling philosophy
    - Each detector should remove its own heat
    - ECAL 120 Mch  $\times 25\mu\text{W} \Rightarrow 3 \text{ kW}$ 
      - with 200 gain from Power Pulsing
  - DAQ
    - 1 Concentrator board per Module
      - + power
      - + condensators





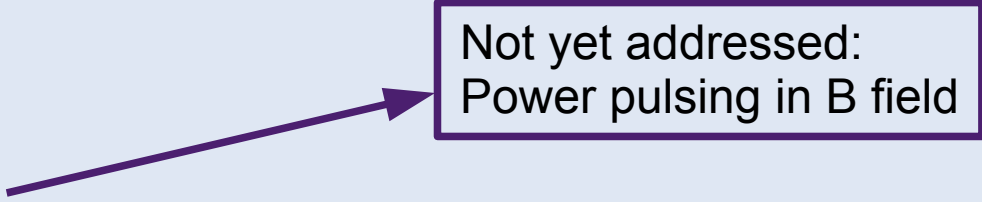


# Main critical points

- Calibration
  - ▶ Answered to IDAG: muon from beam halo, tracks in showers
- SiW: cost of Si, heating → indust. / test of power pulsing
- ScW: reconstruction → coding / manpower
- MAPS: power & integration → physics prototype on the way
- AHCAL: price of SiPM & calibration → indus. + TB analysis
- DHCAL: reconstruction → to be validated in Simulation & TB

→ Construction of complete or partial **technological prototypes**

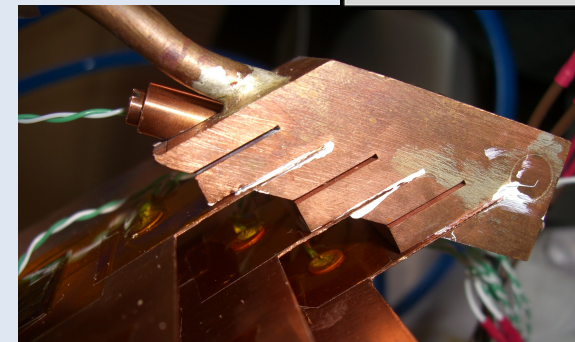
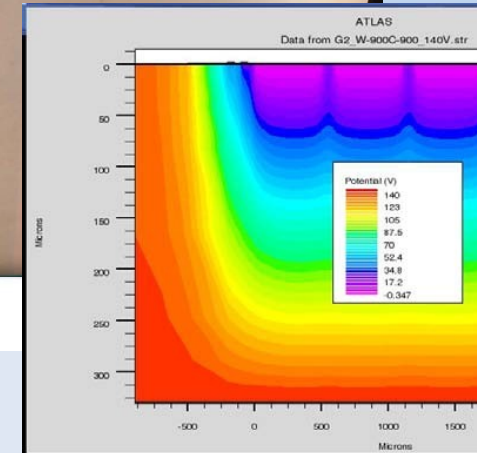
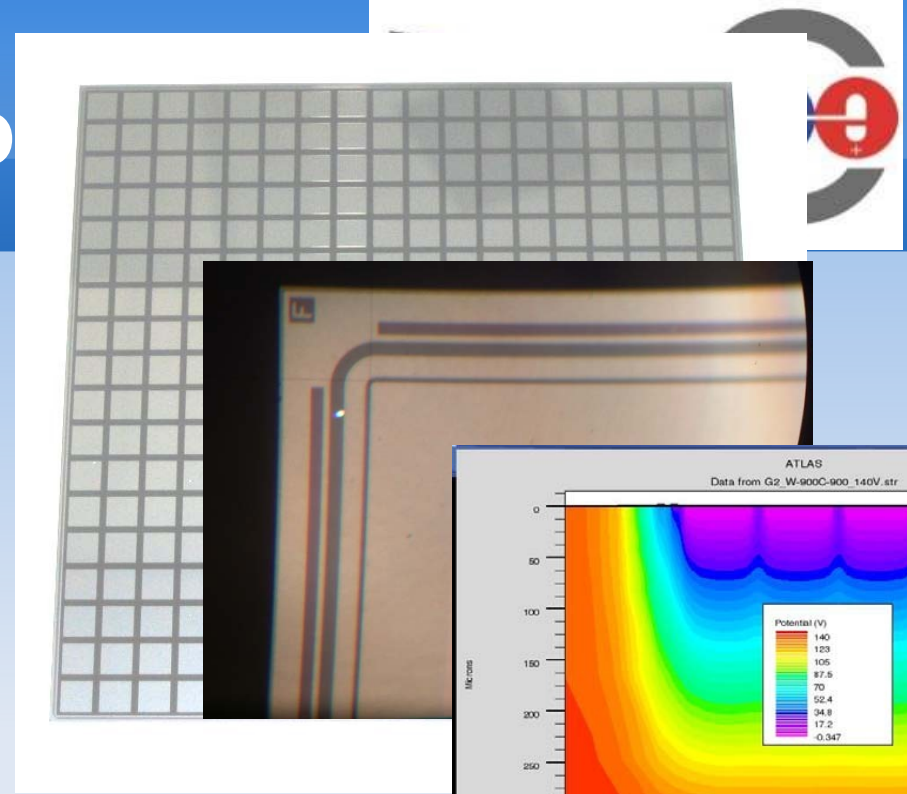
- ▶ embedded ASICS
  - ◆ daisy chain readout
  - ◆ cooling
  - ◆ power pulsing testing
- ▶ (Now) For ECAL, AHCAL & DHCAL



Not yet addressed:  
Power pulsing in B field

# Si/W ECAL Tech. Proto

- 5×5 mm<sup>2</sup> technological prototype (see R. Poeschl talk @ ILD sess.)
  - ▶ 9" wafers with improved guard rings and reduced dead zone
    - ◆ R&D on GR
  - ▶ embedded on board SKYROC2 chips [64 channels; power pulsing; ADC + 8-deep pipeline on chip]
  - ▶ 1 layer of mechanical structure completed
    - ◆ other by mid-2010
  - ▶ Cooling & thermal test ongoing
  - ▶ TB scheduled for mid for 2011
- Most critical problem:
  - ▶ Si sensors prices: now per wafer **10-20€** → **2€ for ILD**
    - ◆ industrialisation (scale) / partnership / competition / self production under investigation during the next 2 years





# EUDET design

Composite Part  
with metallic inserts  
(15 mm thick)

FEV7 CIP at the present time

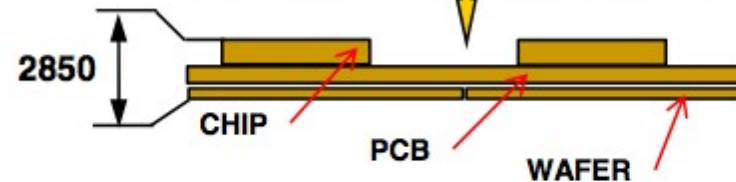
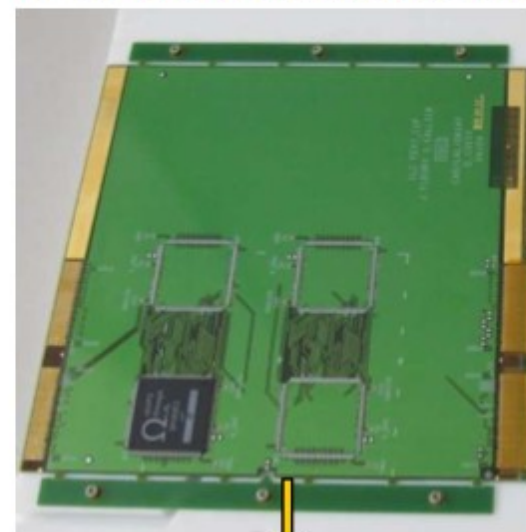
Thickness : 1 mm

182,1 × 9,4 mm

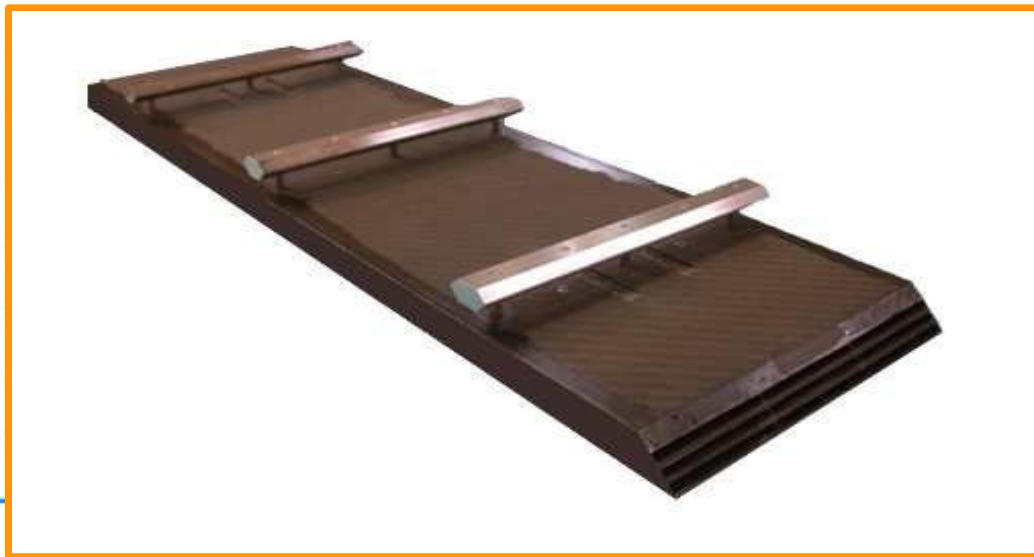
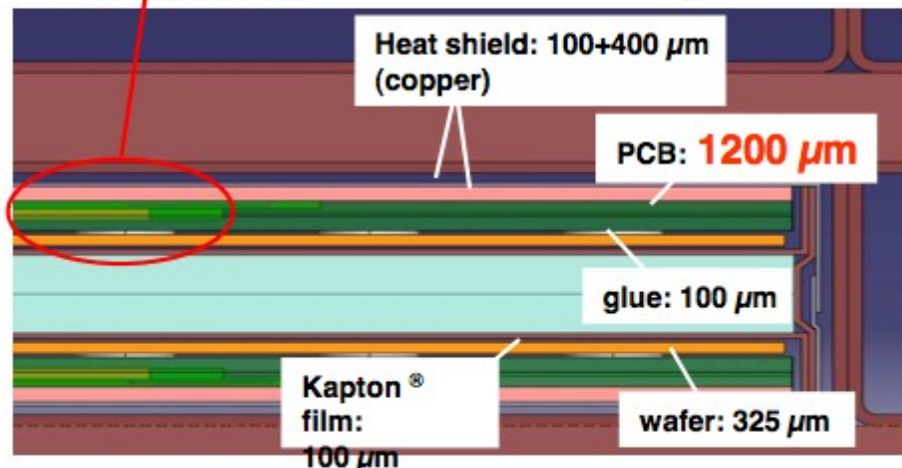
182,1 × 7,3 mm

1495 mm

550 mm



Chips and bonded wires  
inside the PCB

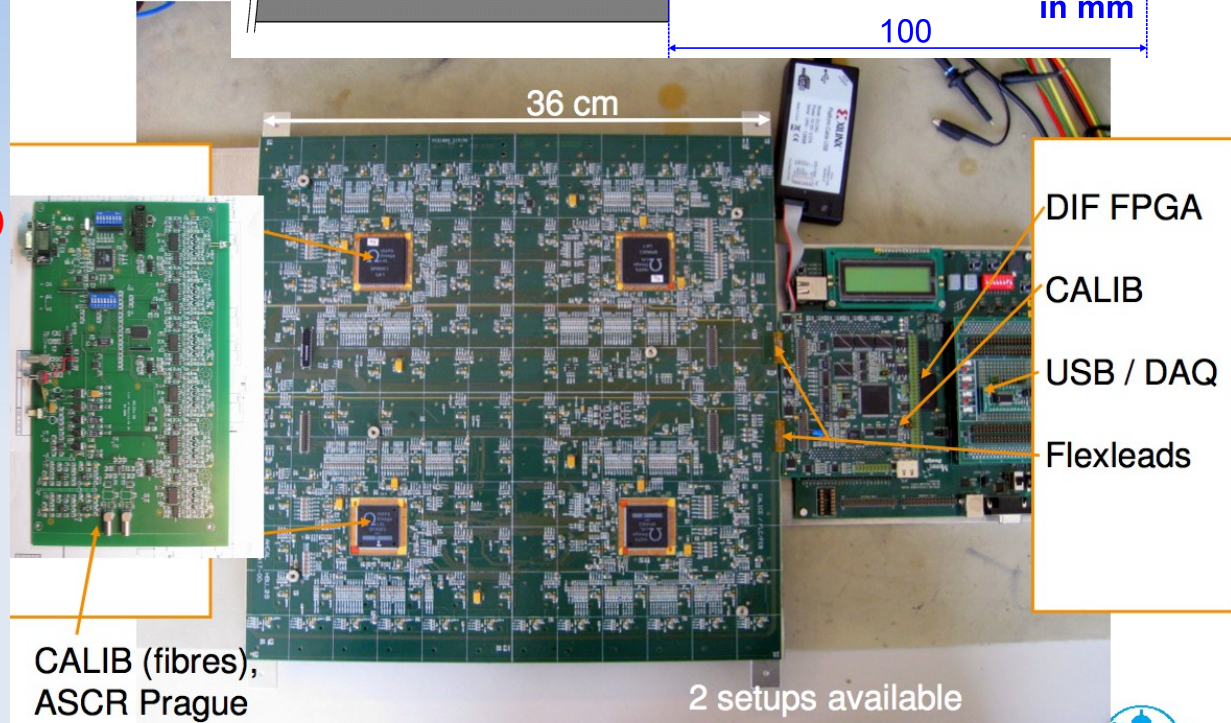
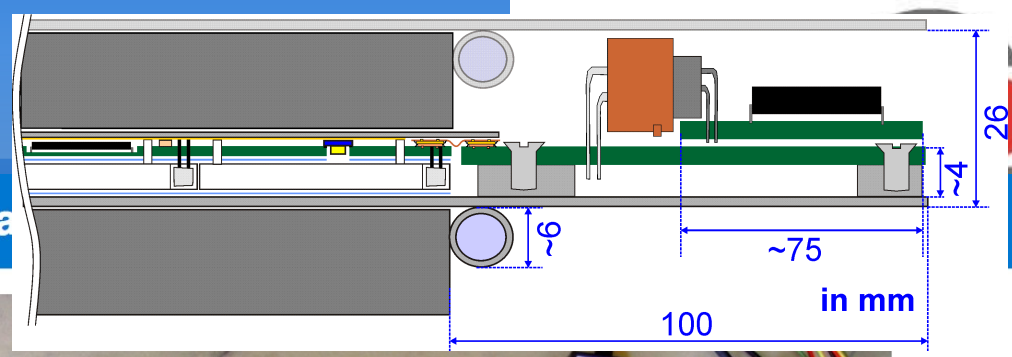




# AHCAL tech. proto

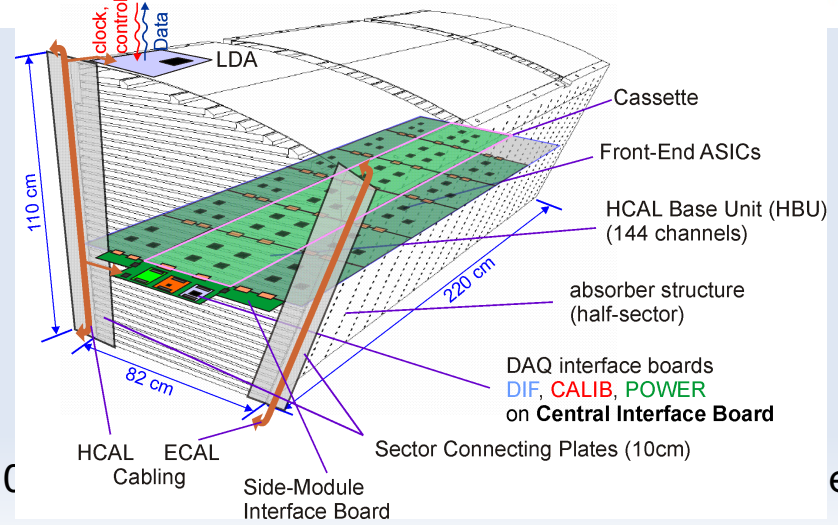
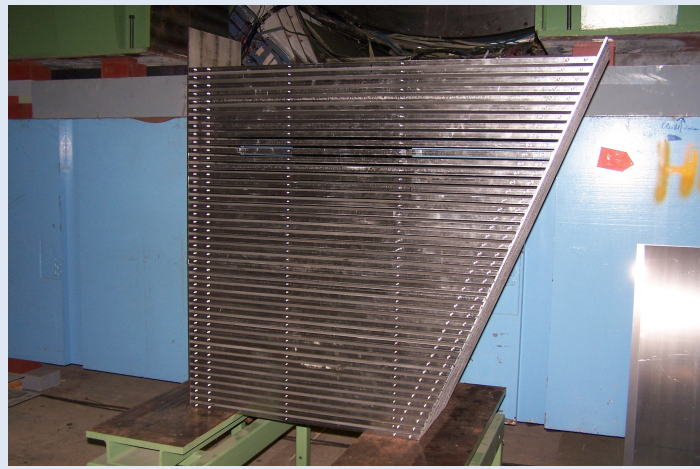
- 1 layer funded
- Electronics integration
  - SPIROC, daisy chain, LED
- Mechanical integration & test
  - SS plates  
mechanical and magnetic properties, price being investigated

HCAL Base



CALIB (fibres),  
ASCR Prague

Mathias Reinecke | CALICE week Lyon | Sept. 16th – 18th, 2009 | Page 6

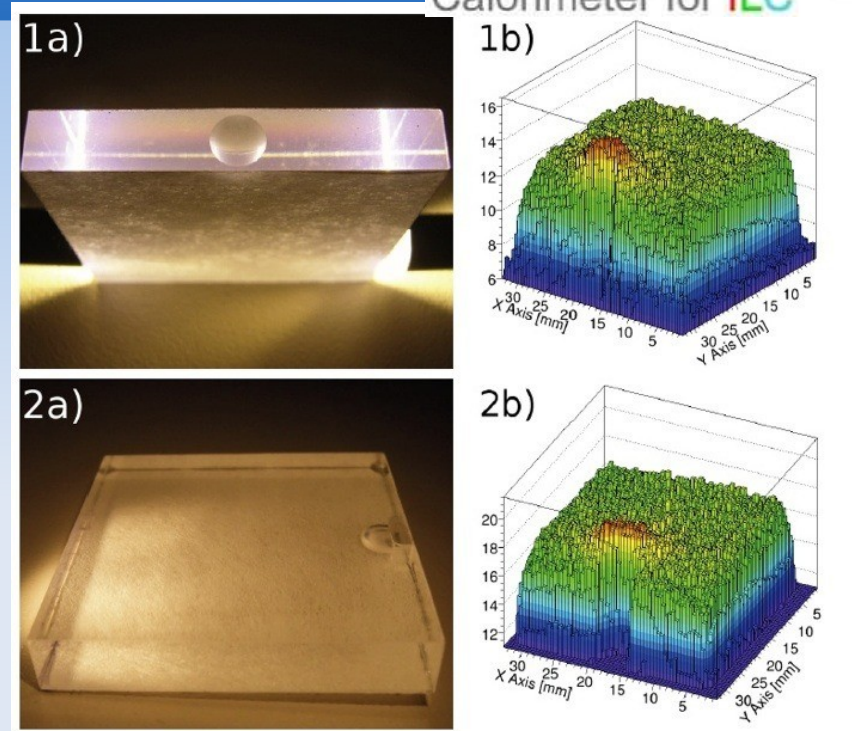




# AHCAL techn. prototype

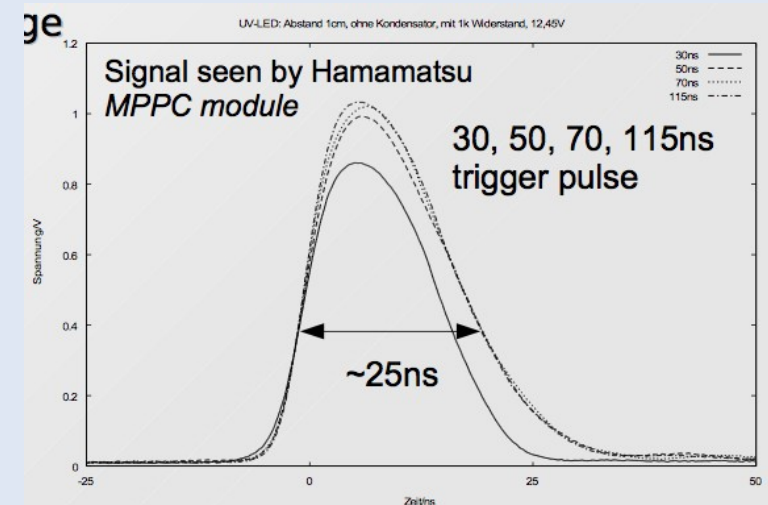
- Tile optimisation

- ▶ without WLS
  - ◆ with or w/o direct coupling
- ▶ optimise for uniformity



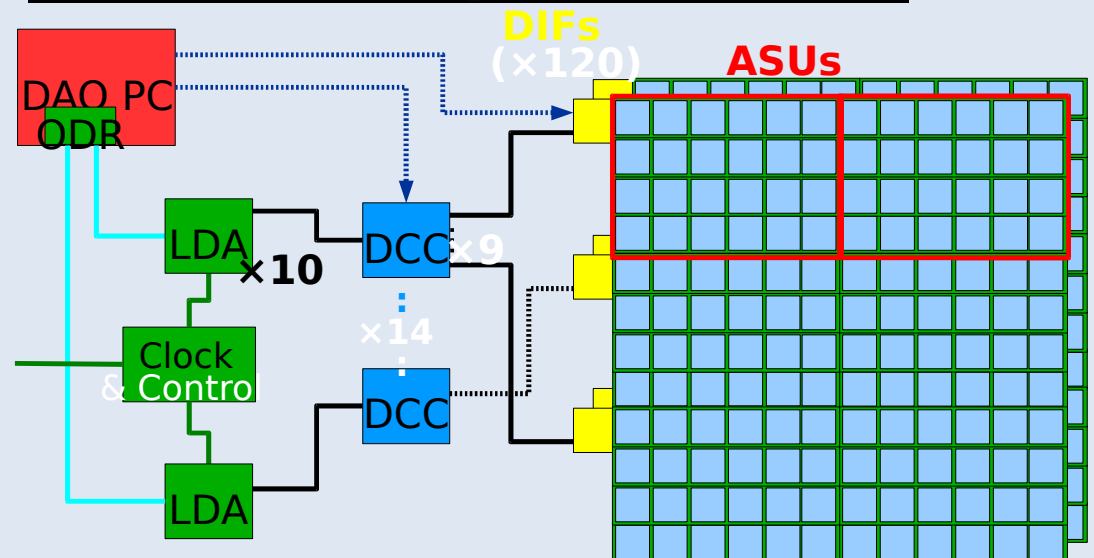
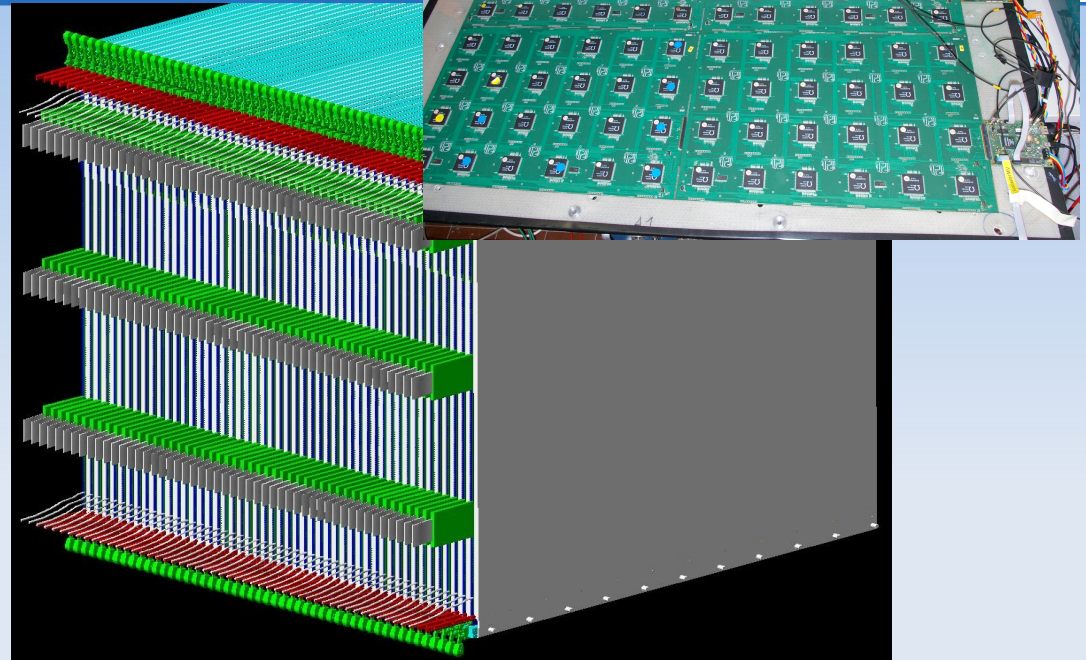
- Embedded LED calibration system

- ▶ 1 blue LED / tile
- ▶ Studies for position &  $t^0$  behaviour



# SDHCAL

- 1 m<sup>3</sup> technological prototype planned
  - ▶ 40 layers with 20 mm SS
  - ▶ Rpc and/or MicroMegas
  - ▶ Hardroc2 (3 thresholds)
- testbeam scheduled for 2010-11
  - ▶ Validation of semi-digital calorimetry
  - ▶ Test of CALICE DAQ2 on 400000 channels



# Overview

- Lot of engineering work in the conception of the ILD calorimetry since the LOI
- Still a lot to do to get the price reduction and establish the perf.
  - ▶ industrialisation studies are starting
    - ◆ mechanics of SS
    - ◆ Si sensors for the Si-W ECAL
  - ▶ performance program well advanced
    - ◆ techn. prototypes of (AHCAL), SDHCAL, SiW ECAL
    - ◆ Physics prototype of MAPS, Scint W, FCALs
  - ▶ Many test beam in the next 2 years
- Main points addressed by IDAG have been / will be responded
  - ▶ power pulsing in B field
    - ◆ Needs special tests  
Under investigation...
- Find a logo for ILD....

# Muon system

- ILD muon system
  - ▶ 10 layers of 10cm Fe yoke + few layers of thick Fe yoke interleaved with muon detectors
  - ▶ Scintillator strip, resistive plate chambers (RPC), or plastic streamer tubes (PST) as the detector
  - ▶ Muon system as “tail catcher” of HCAL: still controversial